

ispPAC⁻POWR1220AT8

In-System Programmable Power Supply Monitoring, Sequencing and Margining Controller

Preliminary Data Sheet

October 2005

Features

- Monitor, Control, and Margin Multiple Power Supplies
 - Simultaneously monitors up to 12 power supplies
 - Provides up to 20 output control signals
 - Provides up to eight analog outputs for margining/trimming power supply voltages
 - Programmable digital and analog circuitry
- Power Supply Margin and Trim Functions
 - Trim and margin up to eight power supplies
 - Dynamic voltage control through I²C
 - Four hardware selectable voltage profiles
 - Independent Digital Closed-Loop Trim function for each output

Embedded PLD for Sequence Control

- 48-macrocell CPLD implements both state machines and combinatorial logic functions
- Embedded Programmable Timers
 - Four independent timers
 DataSheet4
 - 32µs to 2 second intervals for timing sequences

Analog Input Monitoring

- 12 independent analog monitor inputs
- · Differential inputs for remote ground sense
- Two programmable threshold comparators per analog input
- Hardware window comparison
- 10-bit ADC for I²C monitoring

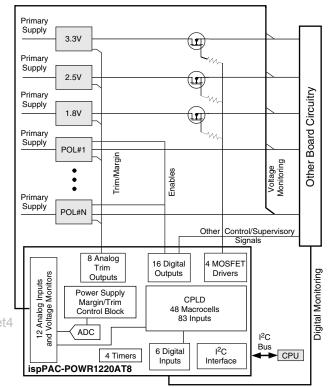
High-Voltage FET Drivers

- Power supply ramp up/down control
- · Programmable current and voltage output
- Independently configurable for FET control or digital output

■ 2-Wire (I²C/SMBus[™] Compatible) Interface

- Comparator status monitor
- ADC readout
- · Direct control of inputs and outputs
- Power sequence control
- Dynamic trimming/margining control
- 3.3V Operation, Wide Supply Range 2.8V to 3.96V
 - In-system programmable through JTAG
 - Industrial temperature range: -40°C to +85°C
 - 100-pin TQFP package, lead-free option

Application Block Diagram



Description

Lattice's Power Manager II ispPAC-POWR1220AT8 is a general-purpose power-supply monitor, sequence and margin controller, incorporating both in-system programmable logic and in-system programmable analog functions implemented in non-volatile E²CMOS[®] technology. The ispPAC-POWR1220AT8 device provides 12 independent analog input channels to monitor up to 12 power supply test points. Each of these input channels offers a differential input to support remote ground sensing, and has two independently programmable comparators to support both high/low and in-bounds/ out-of-bounds (window-compare) monitor functions. Six general-purpose digital inputs are also provided for miscellaneous control functions.

The ispPAC-POWR1220AT8 provides 20 open-drain digital outputs that can be used for controlling DC-DC converters, low-drop-out regulators (LDOs) and opto-couplers, as well as for supervisory and general-purpose logic interface functions. Four of these outputs

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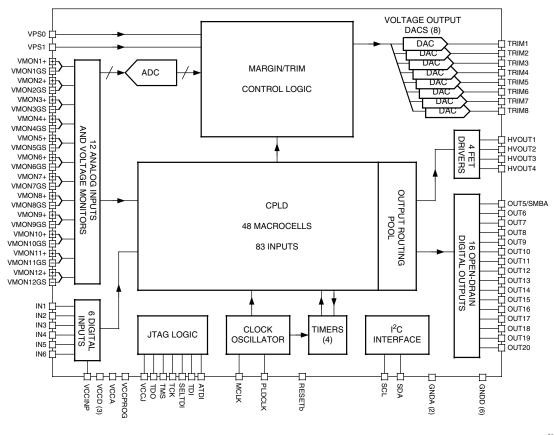
(HVOUT1-HVOUT4) may be configured as high-voltage MOSFET drivers. In high-voltage mode these outputs can provide up to 12 V for driving the gates of n-channel MOSFETs so that they can be used as high-side power switches controlling the supplies with a programmable ramp rate for both ramp up and ramp down.

The ispPAC-POWR1220AT8 incorporates a 48-macrocell CPLD that can be used to implement complex state machine sequencing for the control of multiple power supplies as well as combinatorial logic functions. The status of all of the comparators on the analog input channels as well as the general purpose digital inputs are used as inputs by the CPLD array, and all digital outputs may be controlled by the CPLD. Four independently programmable timers can create delays and time-outs ranging from 32µs to 2 seconds. The CPLD is programmed using Logi-Builder[™], an easy-to-learn language integrated into the PAC-Designer[®] software. Control sequences are written to monitor the status of any of the analog input channel comparators or the digital inputs.

In addition to the sequence control functions, the ispPAC-POWR1220AT8 incorporates eight DACs for generating trimming voltage to control the output voltage of a DC-DC converter. The trimming voltage can be set to four hardware selectable preset values (voltage profiles) or can be dynamically loaded in to the DAC through the I²C bus. Additionally, each power supply output voltage can be maintained typically within 0.5% tolerance across various load conditions using the Digital Closed Loop Control mode. The operating voltage profile can either be selected using external hardware pins or through the PLD outputs.

The on-chip 10-bit A/D converter can both be used to monitor the V_{MON} voltage through the I²C bus as well as for implementing digital closed loop mode for maintaining the output voltage of all power supplies controlled by the monitoring and trimming section of the ispPAC-POWR1220AT8 device.

The I²C bus/SMBus interface allows an external microcontroller to measure the voltages connected to the V_{MON} inputs, read back the status of each of the V_{MON} comparator and PLD outputs, control logic signals IN2 to IN5, control trol the output pins, and load the DACs for the generation of the trimming voltage of the external DC-DC converter.



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Figure 1. ispPAC-POWR1220AT8 Block DiagramtaSheet4U.com

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Pin Descriptions

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| Number | Name | Pin Type | Voltage Range | Description |
|--------------------------|-------------------|--------------------------------|---|--|
| 89 | VPS0 | Digital Input | VCCD | Trim Select Input 0 Registered by MCLK |
| 90 | VPS1 | Digital Input | VCCD | Trim Select Input 1 Registered by MCLK |
| 97 | IN1 ² | Digital Input | VCCINP ¹ | PLD Logic Input 1 Registered by MCLK |
| 1 | IN2 ³ | Digital Input | VCCINP ¹ | PLD Logic Input 2 Registered by MCLK |
| 2 | IN3 ³ | Digital Input | VCCINP ¹ | PLD Logic Input 3 Registered by MCLK |
| 4 | IN4 ³ | Digital Input | VCCINP ¹ | PLD Logic Input 4 Registered by MCLK |
| 6 | IN5 ³ | Digital Input | VCCINP ¹ | PLD Logic Input 5 Registered by MCLK |
| 7 | IN6 ³ | Digital Input | VCCINP ¹ | PLD Logic Input 6 Registered by MCLK |
| 47 | VMON1 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 1 Input |
| 46 | VMON1GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 1 Ground Sense |
| 50 | VMON2 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 2 Input |
| 48 | VMON2GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 2 Ground Sense |
| 52 | VMON3 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 3 Input |
| 51 | VMON3GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 3 Ground Sense |
| 54 | VMON4 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 4 Input |
| 53 | VMON4GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 4 Ground Sense |
| 56 | VMON5 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 5 Input |
| 55 | VMON5GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 5 Ground Sense |
| 58 | VMON6 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 6 Input |
| 57 | VMON6GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 6 Ground Sense |
| 62 | VMON7 | Analog Input | -0.3V to 5.75V ² om | Voltage Monitor 7 Input |
| 61 | VMON7GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 7 Ground Sense |
| 64 | VMON8 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 8 Input |
| 63 | VMON8GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 8 Ground Sense |
| 66 | VMON9 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 9 Input |
| 65 | VMON9GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 9 Ground Sense |
| 68 | VMON10 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 10 Input |
| 67 | VMON10GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 10 Ground Sense |
| 70 | VMON11 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 11 Input |
| 69 | VMON11GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 11 Ground Sense |
| 72 | VMON12 | Analog Input | -0.3V to 5.75V ⁴ | Voltage Monitor 12 Input |
| 71 | VMON12GS | Analog Input | -0.2V to 0.3V ⁵ | Voltage Monitor 12 Ground Sense |
| 3, 22, 36, 43, 88, 98 | GNDD ⁸ | Ground | Ground | Digital Ground |
| 45, 87 | GNDA ⁸ | Ground | Ground | Analog Ground |
| 13, 38, 94 | VCCD ⁷ | Power | 2.8V to 3.96V | Core VCC, Main Power Supply |
| 60 | VCCA ⁷ | Power | 2.8V to 3.96V | Analog Power Supply |
| 5 | VCCINP | Power | 2.25V to 3.6V | VCC for IN[1:6] Inputs |
| 33 | VCCJ | Power | 2.25V to 3.6V | VCC for JTAG Logic Interface Pins |
| 39 | VCCPROG | Power | 3.0V to 3.6V | VCC for E ² Programming when the Device is Not Powered by V _{CCD} or V _{CCA} |
| | | Open Drain Output ⁶ | 0V to 13V | Open-Drain Output 1 |
| 86 | HVOUT1 | Current Source/Sink | 1.5µA to 100µA Source 100µA to 3000µA Sink | High-voltage FET Gate Driver 1 |

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Pin Descriptions (Cont.)

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| Number | Name | Pin Type | Voltage Range | Description |
|--------|-----------|--------------------------------|---|---|
| | | Open Drain Output ⁶ | 0V to 13V | Open-Drain Output 2 |
| 85 | HVOUT2 | Current Source/Sink | 1.5μA to 100μA Source 100μA to 3000μA Sink | High-voltage FET Gate Driver 2 |
| | | Open Drain Output ⁶ | 0V to 13V | Open-Drain Output 3 |
| 42 | HVOUT3 | Current Source/Sink | 1.5µA to 100µA Source 100µA to 3000µA Sink | High-voltage FET Gate Driver 3 |
| | | Open Drain Output ⁶ | OV to 13V | Open-Drain Output 4 |
| 40 | HVOUT4 | Current Source/Sink | 1.5µA to 100µA Source 100µA to 3000µA Sink | High-voltage FET Gate Driver 4 |
| 8 | OUT5_SMBA | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 5, (SMBUS Alert Active Low) |
| 9 | OUT6 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 6 |
| 10 | OUT7 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 7 |
| 11 | OUT8 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 8 |
| 12 | OUT9 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 9 |
| 14 | OUT10 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 10 |
| 15 | OUT11 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 11 |
| 16 | OUT12 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 12 |
| 17 | OUT13 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 13 |
| 18 | OUT14 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 14 |
| 19 | OUT15 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 15 |
| 20 | OUT16 | Open Drain Output ⁶ | 0va655v4U.com | Open-Drain Output 16 |
| 21 | OUT17 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 17 |
| 23 | OUT18 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 18 |
| 24 | OUT19 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 19 |
| 25 | OUT20 | Open Drain Output ⁶ | 0V to 5.5V | Open-Drain Output 20 |
| 84 | TRIM1 | Analog Output | -320mV to +320mV from Programmable DAC Offset | Trim DAC Output 1 |
| 83 | TRIM2 | Analog Output | -320mV to +320mV from Programmable DAC Offset | Trim DAC Output 2 |
| 82 | TRIM3 | Analog Output | -320mV to +320mV from Programmable DAC Offset | Trim DAC Output 3 |
| 80 | TRIM4 | Analog Output | -320mV to +320mV from Programmable DAC Offset | Trim DAC Output 4 |
| 79 | TRIM5 | Analog Output | -320mV to +320mV from Programmable DAC Offset | Trim DAC Output 5 |
| 75 | TRIM6 | Analog Output | -320mV to +320mV from Programmable DAC Offset | Trim DAC Output 6 |
| 74 | TRIM7 | Analog Output | -320mV to +320mV from Programmable DAC Offset | Trim DAC Output 7 |
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Pin Descriptions (Cont.)

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| Number | Name | Pin Type | Voltage Range | Description |
|--|---------------------|----------------|---|--|
| 73 | TRIM8 | Analog Output | -320mV to +320mV from Programmable DAC Offset | Trim DAC Output 8 |
| 91 | RESETb ⁹ | Digital I/O | | Device Reset (Active Low) |
| 95 | PLDCLK | Digital Output | | 250kHz PLD Clock Output (Tristate), CMOS Output |
| 96 | MCLK | Digital I/O | | 8MHz Clock I/O (Tristate), CMOS Drive |
| 34 | TDO | Digital Output | | JTAG Test Data Out |
| 37 | ТСК | Digital Input | | JTAG Test Clock Input |
| 28 | TMS | Digital Input | | JTAG Test Mode Select |
| 31 | TDI | Digital Input | | JTAG Test Data In, TDISEL pin = 1 |
| 30 | ATDI | Digital Input | | JTAG Test Data In (Alternate), TDISEL Pin = 0 |
| 32 | TDISEL | Digital Input | | Select TDI/ATDI Input |
| 92 | SCL | Digital Input | | I ² C Serial Clock Input |
| 93 | SDA | Digital I/O | | I ² C Serial Data, Bi-directional Pin |
| 44, 59 | RESERVED | | | Reserved - Do Not Connect |
| 26, 27, 29, 35, 41, 49, 76, 77, 78, 81, 99, 100 | NC | | | No Internal Connection |

1. [IN1...IN6] are inputs to the PLD. The thresholds for these pins are referenced by the voltage on VCCINP.

2. IN1 pin can also be controlled through JTAG interface.

3. [IN2..IN6] can also be controlled through I²C/SMBus interface Sheet4U.com

4. The VMON inputs can be biased independently from VCCA.

5. The VMONGS inputs are the ground sense line for each given VMON pin. The VMON input pins along with the VMONGS ground sense pins implement a differential pair for each voltage monitor to allow remote sense at the load. VMONGS lines must be connected and are not to exceed -0.2V - +0.3V in reference to the GNDA pin.

6. Open-drain outputs require an external pull-up resistor to a supply.

7. VCCD and VCCA pins must be connected together on the circuit board.

8. GNDA and GNDD pins must be connected together on the circuit board.

9. The RESETb pin should only be used for cascading two or more ispPAC-POWR1220AT8 devices.

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Absolute Maximum Ratings

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Absolute maximum ratings are shown in the table below. Stresses beyond those listed may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the recommended operating conditions of this specification is not implied.

| Symbol | Parameter | Conditions | Min. | Max. | Units |
|---------------------|--|------------|------|------|-------|
| V _{CCD} | Core supply | | -0.5 | 4.5 | V |
| V _{CCA} | Analog supply | | -0.5 | 4.5 | V |
| V _{CCINP} | Digital input supply (IN[1:6]) | | -0.5 | 6 | V |
| V _{CCJ} | JTAG logic supply | | -0.5 | 6 | V |
| V _{CCPROG} | E ² programming supply | | -0.5 | 4 | V |
| V _{IN} | Digital input voltage (all digital I/O pins) | | -0.5 | 6 | V |
| V _{MON+} | V _{MON} input voltage | | -0.5 | 6 | V |
| V _{MONGS} | V _{MON} input voltage ground sense | | -0.5 | 6 | V |
| V | Voltage applied to tri-stated pins | HVOUT[1:4] | -0.5 | 13.3 | V |
| V _{TRI} | voltage applied to thestated pins | OUT[5:20] | -0.5 | 6 | V |
| ISINKMAXTOTAL | Maximum sink current on any output | | | 23 | mA |
| Τ _S | Storage temperature | | -65 | 150 | °C |
| T _A | Ambient temperature | | -65 | 125 | °C |

Recommended Operating Conditions

| Symbol | Parameter | Conditions | Min. | Max. | Units |
|------------------------------------|--|--|--|------|-------|
| V _{CCD,} V _{CCA} | Core supply voltage at pin DataSh | eet4U.com | 2.8 | 3.96 | V |
| V _{CCINP} | Digital input supply for IN[1:6] at pin | | 2.25 | 5.5 | V |
| V _{CCJ} | JTAG logic supply voltage at pin | | 2.25 | 3.6 | V |
| V _{CCPROG} | E ² programming supply at pin | During E ² programming | 3.0 | 3.6 | V |
| V _{IN} | Input voltage at digital input pins | | -0.3 | 5.5 | V |
| V _{MON} | Input voltage at V _{MON} pins | | -0.3 | 5.9 | V |
| V _{MONGS} | Input voltage at V _{MONGS} pins | | -0.2 | 0.3 | V |
| | | OUT[5:20] pins | -0.3 | 5.5 | V |
| V _{OUT} | Open-drain output voltage | HVOUT[1:4] pins in open- drain mode | 2.8 3.96 2.25 5.5 2.25 3.6 ning 3.0 3.6 -0.3 5.5 -0.2 0.3 -0.3 5.5 | V | |
| T _{APROG} | Ambient temperature during programming | | -40 | 85 | °C |
| T _A | Ambient temperature | Power applied | -40 | 85 | °C |

Analog Specifications

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|------------------------------|----------------|--------------------------|------|------|------|-------|
| I _{CC} ¹ | Supply current | | | | 45 | mA |
| I _{CCINP} | Supply current | | | | 5 | mA |
| I _{CCJ} | Supply current | | | | 1 | mA |
| I _{CCPROG} | Supply current | During programming cycle | | | 45 | mA |

1. Includes currents on $V_{\mbox{\scriptsize CCD}}$ and $V_{\mbox{\scriptsize CCA}}$ supplies.

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Voltage Monitors

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|---------------------------|--|------------|-------|------|-------|-------|
| R _{IN} | Input resistance | | 50 | 65 | 80 | kΩ |
| C _{IN} | Input capacitance | | | 8 | | pF |
| V _{MON} Range | Programmable trip-point range | | 0.075 | | 5.734 | V |
| V _Z Sense | Near-ground sense threshold | | 70 | 75 | 80 | mV |
| V _{MON} Accuracy | Absolute accuracy of any trip-point ¹ | | | 0.2 | 0.7 | % |
| HYST | Hysteresis of any trip-point (relative to setting) | | | 1 | | % |
| CMR | Common mode rejection | | | 60 | | dB |

1. Guaranteed by characterization across V_{CCA} range, operating temperature, process.

High Voltage FET Drivers

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units | |
|-----------------|--|---------------------------------------|------|------|------|------------|--|
| V _{PP} | | 12V setting | | 12 | | | |
| | Gate driver output voltage | 10V setting | | 10 | | v | |
| VPP | | 8V setting | | 8 | | | |
| | | 6V setting | | 6 | | | |
| | | | | 1.56 | | | |
| | | | | 3.12 | | | |
| | Gate driver source current (HIGH state) | Seven settings in software heet4U.com | | 6.25 | | | |
| IOUTSRC | | | | 12.5 | | μΑ | |
| | (inclinition) | | | 25 | | | |
| | | | | 50 | | | |
| | | | | 100 | | | |
| | | FAST OFF mode | 2000 | 3000 | | | |
| | Gate driver sink current | | | 100 | | 1 ^ | |
| OUTSINK | (LOW state) | Controlled ramp settings | | 250 | | μA | |
| | | lootango | | 500 | | 1 | |

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| Symbol | Parameter | Conditions | Min | Тур | Max | Units |
|------------------|--|--|------|-----------|-----|-------|
| | Resolution | | | 8(7+sign) | | bits |
| FSR | Full scale range | | | +/-320 | | mV |
| LSB | LSB step size | | | 2.5 | | mV |
| I _{OUT} | Output source/sink current | | -125 | | 125 | μA |
| | | Offset 1 | | 0.6 | | |
| BPZ | Bipolar zero output voltage (code=80h) | Offset 2 | | 0.8 | | v |
| | | Offset 3 | | 1.0 | | |
| | | Offset 4 | | 1.25 | | |
| TS | TrimCell output voltage settling time ¹ | DAC code changed from 80H to FFH or 80H to 00H | | | 2.5 | ms |
| | | Single DAC code change | | 256 | | μs |
| C_LOAD | Maximum load capacitance | | | | 50 | pF |
| TUPDATEM | Update time through I ² C port ² | MCLK = 8MHz | | 260 | | μs |
| TOSE | Total open loop supply voltage error ³ | Full scale DAC corre- sponds to ±5% supply voltage variation | -1% | | +1% | V/V |

1. To 1% of set value with 50pf load connected to trim pins.

2. Total time required to update a single TRIMx output value by setting the associated DAC through the I²C port.

3. This is the total resultant error in the trimmed power supply output voltage referred to any DAC code due to the DAC's INL, DNL, gain, output impedance, offset error and bipolar offset error across the industrial temperature range and the ispPAC-POWR1200AT8 operating V_{CCA} and V_{CCD} ranges.
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ADC Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|---------------|-------------------------|-----------------------------|------|---------|-------------------|-------|
| | ADC Resolution | | | 10 | | Bits |
| VIN | Input range Full Scale | Programmable Attenuator = 1 | 0 | | 2.048 | V |
| | | Programmable Attenuator = 3 | 0 | | 5.75 ¹ | V |
| ADC Step Size | LSB | Programmable Attenuator = 1 | | 2 | | mV |
| ADC Step Size | | Programmable Attenuator = 3 | | 6 | | mV |
| Eattenuator | Error Due to Attenuator | Programmable Attenuator = 3 | | +/- 0.1 | | % |

1. Maximum voltage is limited by V_{MONX} pin (theoretical maximum is 6.144V).

ADC Error Budget Across Entire Operating Temperature Range

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|------------|--------------------------|--|------|-------|------|-------|
| TADC Error | | Measurement Range 600 mV - 2.048V, VMONxGS > -100mV, Attenuator =1 | -8 | +/-4 | 8 | mV |
| | Any Voltage ¹ | at Measurement Range 600 mV - 2.048V, VMONxGS > -200mV, Attenuator =1 | | +/-6 | | mV |
| | | Measurement Range 0 - 2.048V, VMONxGS > -200mV, Attenuator =1 | | +/-10 | | mV |

1. Total error, guaranteed by characterization, includes INL, DNL, Gain, Offset, and PSR specs of the ADC.

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Power-On Reset

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|-------------------|--|------------|------|------|------|-------|
| T _{GOOD} | Power-on reset to valid VMON comparator output | | 2.5 | | | ms |
| V _{TL} | Threshold below which RESETb is LOW ¹ | | | | 2.3 | V |
| V _{TH} | Threshold above which RESETb is HIGH ¹ | | 2.7 | | | V |
| V _T | Threshold above which RESETb is valid ¹ | | 0.8 | | | V |
| T _{POR} | Minimum duration dropout required to trigger RESETb | | 1 | | 5 | μs |
| CL | Capacitive load on RESETb for master/slave operation | | | | 200 | pF |

1. Corresponds to VCCA and VCCD supply voltages.

AC/Transient Characteristics

Over Recommended Operating Conditions

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|---------------------|--|-------------------------|-------|------|------|-------|
| Voltage Monitor | 'S | | | | | |
| t _{PD16} | Propagation delay input to output glitch filter OFF | | | 16 | | μs |
| t _{PD64} | Propagation delay input to output glitch filter ON | | | 64 | | μs |
| Oscillators | | | | | 1 | |
| f _{CLK} | Internal master clock frequency (MCLK) | DataSheet4U.com | 7.2 | 8 | 8.8 | MHz |
| f _{CLKEXT} | Externally applied master clock (MCLK) | | 7.2 | | 8.8 | MHz |
| f _{PLDCLK} | PLDCLK output frequency | f _{CLK} = 8MHz | | 250 | | kHz |
| Timers | | | • | | | |
| Timeout Range | Range of programmable timers (128 steps) | f _{CLK} = 8MHz | 0.032 | | 1966 | ms |
| Resolution | Spacing between available adjacent timer intervals | | | | 13 | % |

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Digital Specifications

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| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|----------------------------------|---|--|------------------------|------|------------------------|-------|
| I _{IL} ,I _{IH} | Input leakage, no pull-up/pull-down | | | | +/-10 | μA |
| I _{OH-HVOUT} | Output leakage current | HVOUT[1:4] in open drain mode and pulled up to 13.2V | | 30 | 60 | μΑ |
| I _{PU} | Input pull-up current (TMS, TDI, TDISEL, ATDI, MCLK) | | | 70 | | μA |
| | | VPS[0:1], TDI, TMS, ATDI, TDISEL, 3.3V supply | | | 0.8 | |
| V _{IL} | Voltage input, logic low ¹ | VPS[0:1], TDI, TMS, ATDI, TDISEL, 2.5V supply | | | 0.7 | V |
| | | IN[1:6] | | | 30% V _{CCINP} | |
| | | VPS[0:1], TDI, TMS, ATDI, TDISEL, 3.3V supply | 2.0 | | | |
| V _{IH} | Voltage input, logic high ¹ | VPS[0:1], TDI, TMS, ATDI, TDISEL, 2.5V supply | 1.7 | | | V |
| | | IN[1:6] | 70% V _{CCINP} | | V _{CCINP} | |
| | HVOUT[1:4] (open drain mode), | I _{SINK} = 10mA | | | 0.8 | |
| V _{OL} | OUT[5:20] | I _{SINK} = 20mA | | | 0.8 | V |
| | TDO,MCLK,PLDCLK | I _{SINK} = 4mA | | | 0.4 | |
| V _{OH} | TDO, MCLK, PLDCLK | I _{SRC} = 4mA | | | V _{CCD} - 0.4 | V |
| ISINKTOTAL | All digital outputs | | | | 130 | mA |

Over Recommended Operating Conditions

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1. VPS[0:1] referenced to V_{CCD}; IN[1:6] referenced to V_{CCINP}; TDO, TDI, TMS, ATDI, TDISEL referenced to V_{CCJ}.

I²C Port Characteristics

| | | 100 | KHz | 400 | KHz | |
|----------------------|---|------|------|------|------|-------|
| Symbol | Definition | Min. | Max. | Min. | Max. | Units |
| F _{I2C} | I ² C clock/data rate | | 100 | | 400 | KHz |
| T _{SU;STA} | After start | 4.7 | | 0.6 | | us |
| T _{HD;STA} | After start | 4 | | 0.6 | | us |
| T _{SU;DAT} | Data setup | 250 | | 100 | | ns |
| T _{SU;STO} | Stop setup | 4 | | 0.6 | | us |
| T _{HD;DAT} | Data hold; SCL= Vih_min = 2.1V | 0.3 | 3.45 | 0.3 | 0.9 | us |
| T _{LOW} | Clock low period | 4.7 | | 1.3 | | us |
| T _{HIGH} | Clock high period | 4 | | 0.6 | | us |
| T _F | Fall time; 2.25V to 0.65V | | 300 | | 300 | ns |
| T _R | Rise time; 0.65V to 2.25V | | 1000 | | 300 | ns |
| T _{TIMEOUT} | Detect clock low timeout | 25 | 35 | 25 | 35 | ms |
| T _{POR} | Device must be operational after power-on reset | 500 | | 500 | | ms |
| T _{BUF} | Bus free time between stop and start condition | 4.7 | | 1.3 | | us |

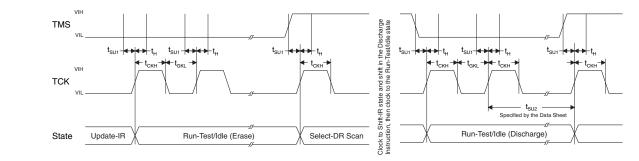
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Timing for JTAG Operations

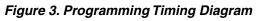
Lattice Semiconductor

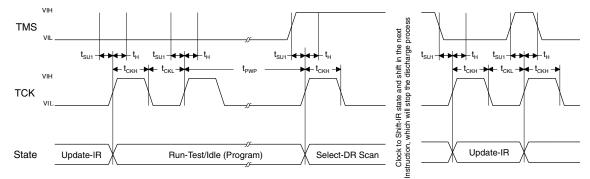
| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|---------------------|--------------------------------------|------------|------|------|------|-------|
| t _{ISPEN} | Program enable delay time | | 10 | — | — | μs |
| t _{ISPDIS} | Program disable delay time | | 30 | — | — | μs |
| t _{HVDIS} | High voltage discharge time, program | | 30 | — | — | μs |
| t _{HVDIS} | High voltage discharge time, erase | | 200 | — | — | μs |
| t _{CEN} | Falling edge of TCK to TDO active | | _ | — | 15 | ns |
| t _{CDIS} | Falling edge of TCK to TDO disable | | _ | — | 15 | ns |
| t _{SU1} | Setup time | | 5 | — | — | ns |
| t _H | Hold time | | 10 | — | — | ns |
| t _{СКН} | TCK clock pulse width, high | | 20 | — | — | ns |
| t _{CKL} | TCK clock pulse width, low | | 20 | — | — | ns |
| f _{MAX} | Maximum TCK clock frequency | | _ | — | 25 | MHz |
| t _{CO} | Falling edge of TCK to valid output | | _ | — | 15 | ns |
| t _{PWV} | Verify pulse width | | 30 | — | — | μs |
| t _{PWP} | Programming pulse width | | 20 | — | — | ms |

Figure 2. Erase (User Erase or Erase All) Timing Diagram



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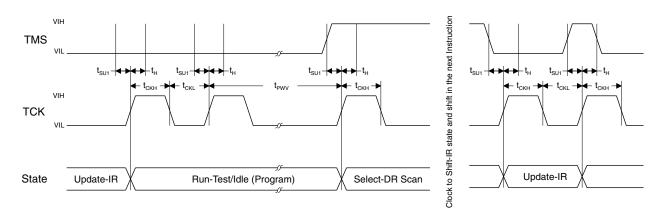
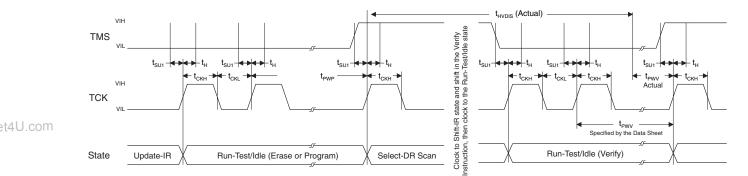


Figure 4. Verify Timing Diagram

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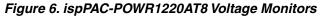
Figure 5. Discharge Timing Diagram



Theory of Operation

Analog Monitor Inputs

The ispPAC-POWR1220AT8 provides 12 independently programmable voltage monitor input circuits as shown in Figure 6. Two individually programmable trip-point comparators are connected to an analog monitoring input. Each comparator reference has 368 programmable trip points over the range of 0.664V to 5.734V. Additionally, a 75mV 'zero-detect' threshold is selectable which allows the voltage monitors to determine if a monitored signal has dropped to ground level. This feature is especially useful for determining if a power supply's output has decayed to a substantially inactive condition after it has been switched off.



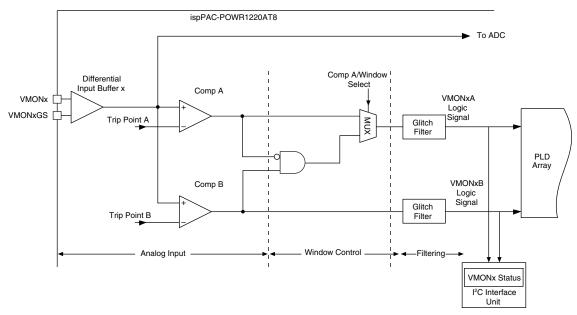


Figure 6 shows the functional block diagram of one of the 12 voltage monitor inputs - 'x' (where x = 1...12). Each voltage monitor can be divided into three sections: Analog Input, Window Control, and Filtering. The first section provides a differential input buffer to monitor the power supply voltage through VMONx+ (to sense the positive terminal of the supply) and VMONxGS (to sense the power supply ground). Differential voltage sensing minimizes inaccuracies in voltage measurement with ADC and monitor thresholds due to the potential difference between the ispPAC-POWR1220AT8 device ground and the ground potential at the sensed node on the circuit board.

The voltage output of the differential input buffer is monitored by two individually programmable trip-point comparators, shown as CompA and CompB. Table 1 shows all 368 trip points spanning the range 0.664V to 5.734V to which a comparator's threshold can be set.

Each comparator outputs a HIGH signal to the PLD array if the voltage at its positive terminal is greater than its programmed trip point setting, otherwise it outputs a LOW signal.

A hysteresis of approximately 1% of the setpoint is provided by the comparators to reduce false triggering as a result of input noise. The hysteresis provided by the voltage monitor is a function of the input divider setting. Table 3 lists the typical hysteresis versus voltage monitor trip-point.

AGOOD Logic Signal

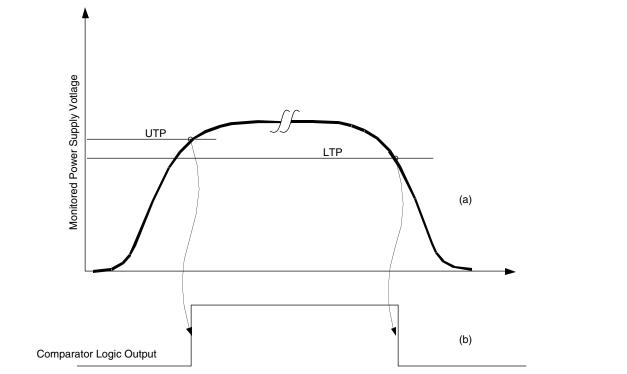
All the VMON comparators auto-calibrate immediately after a power-on reset event. During this time, the digital glitch filters are also initialized. This process completion is signalled by an internally generated logic signal: AGOOD. All logic using the VMON comparator logic signals must wait for the AGOOD signal to become active.

Programmable Over-Voltage and Under-Voltage Thresholds

Figure 7 (a) shows the power supply ramp-up and ramp-down voltage waveforms. Because of hysteresis, the comparator outputs change state at different thresholds depending on the direction of excursion of the monitored power supply.

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During power supply ramp-up the comparator output changes from logic 0 to 1 when the power supply voltage crosses the upper trip point (UTP). During ramp down the comparator output changes from logic state 1 to 0 when the power supply voltage crosses the lower trip point (LTP). To monitor for over voltage fault conditions, the UTP should be used. To monitor under-voltage fault conditions, the LTP should be used.

Tables 1 and 2 show both the under-voltage and over-voltage trip points, which are automatically selected in software depending on whether the user is monitoring for an over-voltage condition or an under-voltage condition.

| Lattice | Semicon | nductor |
|---------|---------|---------|
|---------|---------|---------|

| Fine | Coarse Range Setting | | | | | | | | | | | |
|------------------|----------------------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|
| Range Setting | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 |
| 1 | 0.790 | 0.941 | 1.120 | 1.333 | 1.580 | 1.885 | 2.244 | 2.665 | 3.156 | 3.758 | 4.818 | 5.734 |
| 2 | 0.786 | 0.936 | 1.114 | 1.326 | 1.571 | 1.874 | 2.232 | 2.650 | 3.139 | 3.738 | 4.792 | 5.703 |
| 3 | 0.782 | 0.930 | 1.108 | 1.319 | 1.563 | 1.864 | 2.220 | 2.636 | 3.123 | 3.718 | 4.766 | 5.674 |
| 4 | 0.778 | 0.926 | 1.102 | 1.312 | 1.554 | 1.854 | 2.209 | 2.622 | 3.106 | 3.698 | 4.741 | 5.643 |
| 5 | 0.773 | 0.921 | 1.096 | 1.305 | 1.546 | 1.844 | 2.197 | 2.607 | 3.089 | 3.678 | 4.715 | 5.612 |
| 6 | 0.769 | 0.916 | 1.090 | 1.298 | 1.537 | 1.834 | 2.185 | 2.593 | 3.072 | 3.657 | 4.689 | 5.581 |
| 7 | 0.765 | 0.911 | 1.084 | 1.290 | 1.529 | 1.825 | 2.173 | 2.579 | 3.056 | 3.637 | 4.663 | 5.550 |
| 8 | 0.761 | 0.906 | 1.078 | 1.283 | 1.520 | 1.815 | 2.161 | 2.565 | 3.039 | 3.618 | 4.638 | 5.520 |
| 9 | 0.756 | 0.901 | 1.072 | 1.276 | 1.512 | 1.805 | 2.149 | 2.550 | 3.022 | 3.598 | 4.612 | 5.489 |
| 10 | 0.752 | 0.896 | 1.066 | 1.269 | 1.503 | 1.795 | 2.137 | 2.536 | 3.005 | 3.578 | 4.586 | 5.459 |
| 11 | 0.748 | 0.891 | 1.060 | 1.262 | 1.495 | 1.785 | 2.125 | 2.522 | 2.988 | 3.558 | 4.561 | 5.428 |
| 12 | 0.744 | 0.886 | 1.054 | 1.255 | 1.486 | 1.774 | 2.113 | 2.507 | 2.971 | 3.537 | 4.535 | 5.397 |
| 13 | 0.739 | 0.881 | 1.048 | 1.248 | 1.478 | 1.764 | 2.101 | 2.493 | 2.954 | 3.517 | 4.509 | 5.366 |
| 14 | 0.735 | 0.876 | 1.042 | 1.240 | 1.470 | 1.754 | 2.089 | 2.479 | 2.937 | 3.497 | 4.483 | 5.336 |
| 15 | 0.731 | 0.871 | 1.036 | 1.233 | 1.461 | 1.744 | 2.077 | 2.465 | 2.920 | 3.477 | 4.457 | 5.305 |
| 16 | 0.727 | 0.866 | 1.030 | 1.226 | 1.453 | 1.734 | 2.064 | 2.450 | 2.903 | 3.457 | 4.431 | 5.274 |
| 17 | 0.723 | 0.861 | 1.024 | 1.219 | 1.444 | 1.724 | 2.052 | 2.436 | 2.886 | 3.437 | 4.406 | 5.244 |
| 18 | 0.718 | 0.856 | 1.018 | 1.212 | 1.436 | 1.714 | 2.040 | 2.422 | 2.869 | 3.416 | 4.380 | 5.213 |
| 19 | 0.714 | 0.851 | 1.012 | 1.205 | 1.427 | 1.704 | 2.028 | 2.407 | 2.852 | 3.396 | 4.355 | 5.183 |
| 20 | 0.710 | 0.846 | 1.006 | 1.198 | 1.419 | 1.694 | 2.016 | 2.393 | 2.836 | 3.376 | 4.329 | 5.152 |
| 21 | 0.706 | 0.841 | 1.000 | 1.190 | 1.410 | 1.684 | 2.004 | 2.379 | 2.819 | 3.356 | 4.303 | 5.121 |
| 22 | 0.701 | 0.836 | 0.994 | 1.183 | 1.402 | 1.673 | 1.992 | 2.365 | 2.802 | 3.336 | 4.277 | 5.090 |
| 23 | 0.697 | 0.831 | 0.988 | 1.176 | 1.393 | 1.663 | 1.980 | 2.350 | 2.785 | 3.316 | 4.251 | 5.059 |
| 24 | 0.693 | 0.826 | 0.982 | 1.169 | 1.385 | 1.653 | 1.968 | 2.337 | 2.768 | 3.296 | 4.225 | 5.030 |
| 25 | 0.689 | 0.821 | 0.976 | 1.162 | 1.376 | 1.643 | 1.956 | 2.323 | 2.752 | 3.276 | 4.199 | 4.999 |
| 26 | 0.684 | 0.816 | 0.970 | 1.155 | 1.369 | 1.633 | 1.944 | 2.309 | 2.735 | 3.256 | 4.174 | 4.968 |
| 27 | 0.680 | 0.810 | 0.964 | 1.148 | 1.361 | 1.623 | 1.932 | 2.294 | 2.718 | 3.236 | 4.149 | 4.937 |
| 28 | 0.676 | 0.805 | 0.958 | 1.140 | 1.352 | 1.613 | 1.920 | 2.280 | 2.701 | 3.216 | 4.123 | 4.906 |
| 29 | 0.672 | 0.800 | 0.952 | 1.133 | 1.344 | 1.603 | 1.908 | 2.266 | 2.684 | 3.196 | 4.097 | 4.876 |
| 30 | 0.668 | 0.795 | 0.946 | 1.126 | — | 1.593 | 1.896 | 2.251 | — | 3.176 | 4.071 | 4.845 |
| Low-V Sense | | 75mV | | | | | | | | | | |

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| Lattice | Semicon | nductor |
|---------|---------|---------|
|---------|---------|---------|

| Fine | Coarse Range Setting | | | | | | | | | | | |
|------------------|----------------------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|
| Range Setting | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 |
| 1 | 0.786 | 0.936 | 1.114 | 1.326 | 1.571 | 1.874 | 2.232 | 2.650 | 3.139 | 3.738 | 4.792 | 5.703 |
| 2 | 0.782 | 0.930 | 1.108 | 1.319 | 1.563 | 1.864 | 2.220 | 2.636 | 3.123 | 3.718 | 4.766 | 5.674 |
| 3 | 0.778 | 0.926 | 1.102 | 1.312 | 1.554 | 1.854 | 2.209 | 2.622 | 3.106 | 3.698 | 4.741 | 5.643 |
| 4 | 0.773 | 0.921 | 1.096 | 1.305 | 1.546 | 1.844 | 2.197 | 2.607 | 3.089 | 3.678 | 4.715 | 5.612 |
| 5 | 0.769 | 0.916 | 1.090 | 1.298 | 1.537 | 1.834 | 2.185 | 2.593 | 3.072 | 3.657 | 4.689 | 5.581 |
| 6 | 0.765 | 0.911 | 1.084 | 1.290 | 1.529 | 1.825 | 2.173 | 2.579 | 3.056 | 3.637 | 4.663 | 5.550 |
| 7 | 0.761 | 0.906 | 1.078 | 1.283 | 1.520 | 1.815 | 2.161 | 2.565 | 3.039 | 3.618 | 4.638 | 5.520 |
| 8 | 0.756 | 0.901 | 1.072 | 1.276 | 1.512 | 1.805 | 2.149 | 2.550 | 3.022 | 3.598 | 4.612 | 5.489 |
| 9 | 0.752 | 0.896 | 1.066 | 1.269 | 1.503 | 1.795 | 2.137 | 2.536 | 3.005 | 3.578 | 4.586 | 5.459 |
| 10 | 0.748 | 0.891 | 1.060 | 1.262 | 1.495 | 1.785 | 2.125 | 2.522 | 2.988 | 3.558 | 4.561 | 5.428 |
| 11 | 0.744 | 0.886 | 1.054 | 1.255 | 1.486 | 1.774 | 2.113 | 2.507 | 2.971 | 3.537 | 4.535 | 5.397 |
| 12 | 0.739 | 0.881 | 1.048 | 1.248 | 1.478 | 1.764 | 2.101 | 2.493 | 2.954 | 3.517 | 4.509 | 5.366 |
| 13 | 0.735 | 0.876 | 1.042 | 1.240 | 1.470 | 1.754 | 2.089 | 2.479 | 2.937 | 3.497 | 4.483 | 5.336 |
| 14 | 0.731 | 0.871 | 1.036 | 1.233 | 1.461 | 1.744 | 2.077 | 2.465 | 2.920 | 3.477 | 4.457 | 5.305 |
| 15 | 0.727 | 0.866 | 1.030 | 1.226 | 1.453 | 1.734 | 2.064 | 2.450 | 2.903 | 3.457 | 4.431 | 5.274 |
| 16 | 0.723 | 0.861 | 1.024 | 1.219 | 1.444 | 1.724 | 2.052 | 2.436 | 2.886 | 3.437 | 4.406 | 5.244 |
| 17 | 0.718 | 0.856 | 1.018 | 1.212 | 1.436 | 1.714 | 2.040 | 2.422 | 2.869 | 3.416 | 4.380 | 5.213 |
| 18 | 0.714 | 0.851 | 1.012 | 1.205 | 1.427 | 1.704 | 2.028 | 2.407 | 2.852 | 3.396 | 4.355 | 5.183 |
| 19 | 0.710 | 0.846 | 1.006 | 1.198 | 1.419 | 1.694 | 2.016 | 2.393 | 2.836 | 3.376 | 4.329 | 5.152 |
| 20 | 0.706 | 0.841 | 1.000 | 1.190 | 1.410 | 1.684 | 2.004 | 2.379 | 2.819 | 3.356 | 4.303 | 5.121 |
| 21 | 0.701 | 0.836 | 0.994 | 1.183 | 1.402 | 1.673 | 1.992 | 2.365 | 2.802 | 3.336 | 4.277 | 5.090 |
| 22 | 0.697 | 0.831 | 0.988 | 1.176 | 1.393 | 1.663 | 1.980 | 2.350 | 2.785 | 3.316 | 4.251 | 5.059 |
| 23 | 0.693 | 0.826 | 0.982 | 1.169 | 1.385 | 1.653 | 1.968 | 2.337 | 2.768 | 3.296 | 4.225 | 5.030 |
| 24 | 0.689 | 0.821 | 0.976 | 1.162 | 1.376 | 1.643 | 1.956 | 2.323 | 2.752 | 3.276 | 4.199 | 4.999 |
| 25 | 0.684 | 0.816 | 0.970 | 1.155 | 1.369 | 1.633 | 1.944 | 2.309 | 2.735 | 3.256 | 4.174 | 4.968 |
| 26 | 0.680 | 0.810 | 0.964 | 1.148 | 1.361 | 1.623 | 1.932 | 2.294 | 2.718 | 3.236 | 4.149 | 4.937 |
| 27 | 0.676 | 0.805 | 0.958 | 1.140 | 1.352 | 1.613 | 1.920 | 2.280 | 2.701 | 3.216 | 4.123 | 4.906 |
| 28 | 0.672 | 0.800 | 0.952 | 1.133 | 1.344 | 1.603 | 1.908 | 2.266 | 2.684 | 3.196 | 4.097 | 4.876 |
| 29 | 0.668 | 0.795 | 0.946 | 1.126 | 1.335 | 1.593 | 1.896 | 2.251 | 2.667 | 3.176 | 4.071 | 4.845 |
| 30 | 0.664 | 0.790 | 0.940 | 1.119 | — | 1.583 | 1.884 | 2.236 | — | 3.156 | 4.045 | 4.815 |
| Low-V Sense | | 75mV | | | | | | | | | 1 | |

Table 2. Trip Point Table Used For Under-Voltage Detection

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| Trip-point | Trip-point Range (V) | | | | | | |
|------------|----------------------|----|--|--|--|--|--|
| Low Limit | Low Limit High Limit | | | | | | |
| 0.664 | 0.79 | 8 | | | | | |
| 0.79 | 0.941 | 10 | | | | | |
| 0.94 | 1.12 | 12 | | | | | |
| 1.119 | 1.333 | 14 | | | | | |
| 1.326 | 1.58 | 17 | | | | | |
| 1.583 | 1.885 | 20 | | | | | |
| 1.884 | 2.244 | 24 | | | | | |
| 2.236 | 2.665 | 28 | | | | | |
| 2.65 | 3.156 | 34 | | | | | |
| 3.156 | 3.758 | 40 | | | | | |
| 4.045 | 4.818 | 51 | | | | | |
| 4.815 | 5.734 | 61 | | | | | |
| 75 | 0 (Disabled) | | | | | | |

Table 3. Comparator Hysteresis vs. Trip-Point

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The window control section of the voltage monitor circuit is an AND gate (with inputs: an inverted COMPA "ANDed" with COMPB signal) and a multiplexer that supports the ability to develop a 'window' function without using any of the PLD's resources. Through the use of the multiplexer, voltage monitor's 'A' output may be set to report either the status of the 'A' comparator, or the window function of both comparator outputs. The voltage monitor's 'A' output indicates whether the input signal is between or outside the two comparator thresholds. **Important:** This windowing function is only valid in cases where the threshold of the 'A' comparator is set to a value higher than that of the 'B' comparator. Table 4 shows the operation of window function logic.

Table 4. Voltage Monitor Windowing Logic

| Input Voltage | Comp A | Comp B | Window (B and Not A) | Comment |
|---|--------|--------|-------------------------|----------------------|
| V _{IN} < Trip-point B < Trip-point A | 0 | 0 | 0 | Outside window, low |
| Trip-point B < V _{IN} < Trip-point A | 0 | 1 | 1 | Inside window |
| Trip-point B < Trip-point A < V _{IN} | 1 | 1 | 0 | Outside window, high |

Note that when the 'A' output of the voltage monitor circuit is set to windowing mode, the 'B' output continues to monitor the output of the 'B' comparator. This can be useful in that the 'B' output can be used to augment the windowing function by determining if the input is above or below the windowing range.

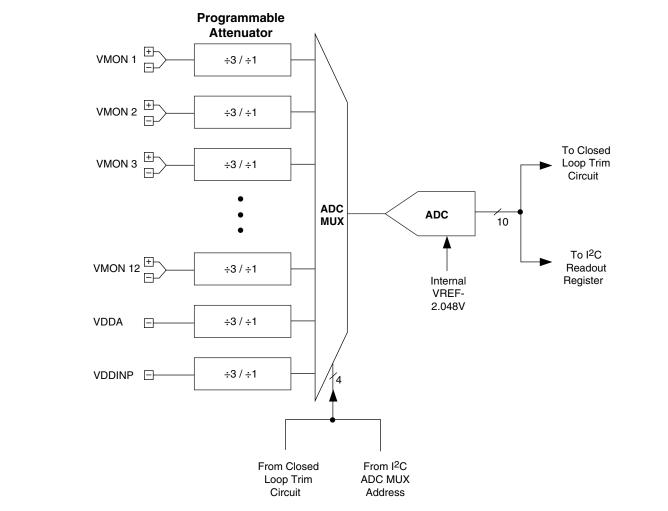
The third section in the ispPAC-POWR1220AT8's input voltage monitor is a digital filter. When enabled, the comparator output will be delayed by a filter time constant of 64 μ S, and is especially useful for reducing the possibility of false triggering from noise that may be present on the voltages being monitored. When the filter is disabled, the comparator output will be delayed by 16 μ S. In both cases, enabled or disabled, the filters also provide synchronization of the input signals to the PLD clock. This synchronous sampling feature effectively eliminates the possibility of race conditions from occurring in any subsequent logic that is implemented in the ispPAC-POWR1220AT8's internal PLD logic.

The comparator status can be read from the I^2C interface. For details on the I^2C interface, please refer to the $I^2C/SMBUS$ Interface section of this data sheet.

VMON Voltage Measurement with the On-chip Analog to Digital Converter (ADC)

The ispPAC-POWR1220 has an on-chip analog to digital converter that can be used for measuring the voltages at the VMON inputs. The ADC is also used in closed loop trimming of DC-DC converters. Close loop trimming is covered later in this document.

Figure 8. ADC Monitoring VMON1 to VMON12



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Figure 8 shows the ADC circuit arrangement within the ispPAC-POWR1220AT8 device. The ADC can measure all analog input voltages through the multiplexer, ADC MUX. The programmable attenuator between the ADC mux and VMON pins can be configured as divided-by-3 or divided-by-1 (no attenuation). The divided-by-3 setting is used to measure voltages from 0V to 6V range and divided-by-1 setting is used to measure the voltages from 0V to 2V range.

A microcontroller can place a request for any VMON voltage measurement at any time through the I²C bus. Upon the receipt of an I²C command, the ADC will be connected to the I²C selected VMON through the ADC MUX. The ADC output is then latched into the I²C readout registers.

Calculation

The algorithm to convert the read ADC code to the corresponding voltage should always consider the attenuation bit value. If the read attenuation bit is set, then one should multiply the ADC code by 3 to calculate the actual voltage at that VMON input. The following formula should be used to calculate the actual voltage from the ADC code.

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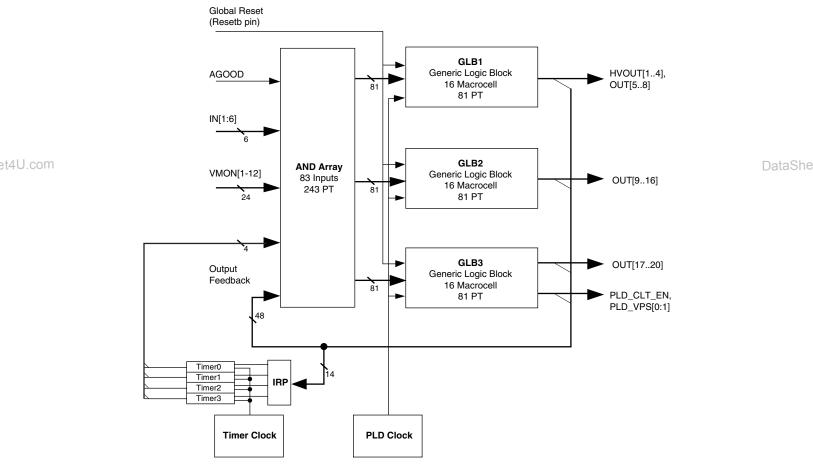
Voltage at the VMONx Pins

VMON = ADC code (12 bits¹, converted to decimal) * 2mV ¹Note: ADC_VALUE_HIGH (8 bits), ADC_VALUE_LOW (4 bits) read from I²C/SMBUS interface

PLD Block

Figure 9 shows the ispPAC-POWR1220AT8 PLD architecture, which is derived from the Lattice's ispMACH[™] 4000 CPLD. The PLD architecture allows the flexibility in designing various state machines and control functions used for power supply management. The AND array has 83 inputs and generates 243 product terms. These 243 product terms are divided into three groups of 81 for each of the generic logic blocks, GLB1, GLB2, and GLB3. Each GLB is made up of 16 macrocells. In total, there are 48 macrocells in the ispPAC-POWR1220AT8 device. The output signals of the ispPAC-POWR1220AT8 device are derived from GLBs as shown in Figure 9. Additionally, the GLB3 generates the timer control and trimming block controls.

Figure 9. ispPAC-POWR1220AT8 PLD Architecture



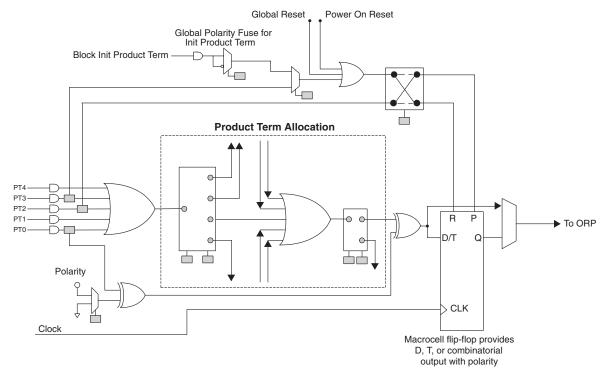
Macrocell Architecture

The macrocell shown in Figure 10 is the heart of the PLD. The basic macrocell has five product terms that feed the OR gate and the flip-flop. The flip-flop in each macrocell is independently configured. It can be programmed to function as a D-Type or T-Type flip-flop. Combinatorial functions are realized by bypassing the flip-flop. The polarity control and XOR gates provide additional flexibility for logic synthesis. The flip-flop's clock is driven from the common PLD clock that is generated by dividing the 8 MHz master clock by 32. The macrocell also supports asynchronous reset and preset functions, derived from either product terms, the global reset input, or the power-on reset signal. The resources within the macrocells share routing and contain a product term allocation array. The product term allocation array greatly expands the PLD's ability to implement complex logical functions by allowing logic to be shared between adjacent blocks and distributing the product terms to allow for wider decode functions.

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Figure 10. ispPAC-POWR1220AT8 Macrocell Block Diagram

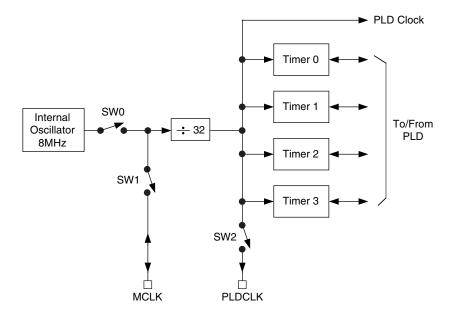


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Clock and Timer Functions

Figure 11 shows a block diagram of the ispPAC-POWR1220AT8's internal clock and timer systems. The master clock operates at a fixed frequency of 8MHz, from which a fixed 250kHz PLD clock is derived.

Figure 11. Clock and Timer System



The internal oscillator runs at a fixed frequency of 8 MHz. This signal is used as a source for the PLD and timer clocks. It is also used for clocking the comparator outputs and clocking the digital filters in the voltage monitor cir-

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cuits, ADC and trim circuits. The ispPAC-POWR1220AT8 can be programmed to operate in three modes: Master mode, Standalone mode and Slave mode. Table 5 summarizes the operating modes of ispPAC-POWR1220AT8.

| Timer Operating Mode | SW0 | SW1 | Condition | Comments |
|-------------------------|--------|--------|--|-----------------------------|
| Standalone | Closed | Open | When only one ispPAC-POWR1220AT8 is used. | MCLK pin tristated |
| Master | Closed | Closed | When more than one ispPAC-POWR1220AT8 is used in a board, one of them should be configured to operate in this mode. | MCLK pin outputs 8MHz clock |
| Slave | Open | Closed | When more than one ispPAC-POWR1220AT8s is used in a board. Other than the master, the rest of the ispPAC-POWR1220AT8s should be pro- grammed as slaves. | MCLK pin is input |

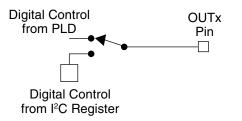
Table 5. ispPAC-POWR1220AT8 Operating Modes

A divide-by-32 prescaler divides the internal 8MHz oscillator (or external clock, if selected) down to 250kHz for the PLD clock and for the programmable timers. This PLD clock may be made available on the PLDCLK pin by closing SW2. Each of the four timers provides independent timeout intervals ranging from 32µs to 1.96 seconds in 128 steps.

Digital Outputs

The ispPAC-POWR1220AT8 provides 20 digital outputs, HVOUT[1:4] and OUT[5:20]. Outputs OUT[5:20] are permanently configured as open drain to provide a high degree of flexibility when interfacing to logic signals, LEDs, opto-couplers, and power supply control inputs. The HVOUT[1:4] pins can be configured as either high voltage FET drivers or open drain outputs. Each of these outputs may be controlled either from the PLD or from the I²C bus. The determination whether a given output is under PLD or I²C control may be made on a pin-by-pin basis (see Figure 12). For further details on controlling the outputs through I²C, please see the I²C/SMBUS Interface section of this data sheet.

Figure 12. Digital Output Pin Configuration



High-Voltage Outputs

In addition to being usable as digital open-drain outputs, the ispPAC-POWR1220AT8's HVOUT1-HVOUT4 output pins can be programmed to operate as high-voltage FET drivers. Figure 13 shows the details of the HVOUT gate drivers. Each of these outputs may be controlled from the PLD or from the I²C bus (see Figure 13). For further details on controlling the outputs through I²C, please see the I²C/SMBUS Interface section of this data sheet.

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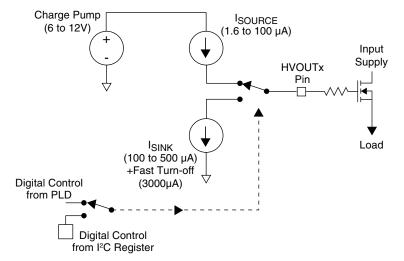


Figure 13. Basic Function Diagram for an Output in High Voltage MOSFET Gate Driver Mode

Figure 13 shows the HVOUT circuitry when programmed as a FET driver. In this mode the output either sources current from a charge pump or sinks current. The maximum voltage that the output level at the pin will rise to is also programmable between 6V and 12V. The maximum voltage levels that are required depend on the gate-to-source threshold of the FET being driven and the power supply voltage being switched. The maximum voltage level needs to be sufficient to bias the gate-to-source threshold on and also accommodate the load voltage at the FET's source, since the source pin of the FET to provide a wide range of ramp rates is tied to the supply of the target board. When the HVOUT pin is sourcing current, charging a FET gate, the source current is programmable between 1.6μ A and 100μ A. When the driver is turned to the off state, the driver will sink current to ground, and this sink current is also programmable between 3000μ A and 100μ A to control the turn-off rate.

Programmable Output Voltage Levels for HVOUT1- HVOUT4

There are four selectable steps for the output voltage of the FET drivers when in FET driver mode. The voltage that the pin is capable of driving to can be programmed from 6V to 12V in 2V steps.

Controlling Power Supply Output Voltage by Margin/ Trim Block

One of the key features of the ispPAC-POWR1220AT8 is its ability to make adjustments to the power supplies that it may also be monitoring and/or sequencing. This is accomplished through the Trim and Margin Block of the device. The Trim and Margin Block can adjust voltages of up to eight different power supplies through TrimCells as shown in Figure 14. The DC-DC blocks in the figure represent virtually any type of DC power supply that has a trim or voltage adjustment input. This can be an off-the-shelf unit or custom circuit designed around a switching regulator IC.

The interface between the ispPAC-POWR1220AT8 and the DC power supply is represented by a single resistor (R1 to R8) to simplify the diagram. Each of these resistors represents a resistor network.

Other control signals driving the Margin/Trim Block are:

- VPS [1:0] Control signals from device pins common to all eight TrimCells, which are used to select the active voltage profile for all TrimCells together.
- PLD_VPS[1:0] Voltage profile selection signals generated by the PLD. These signals can be used instead
 of the VPS signals from the pins.
- ADC input Used to determine the trimmed DC-DC converter voltage.
- PLD_CLT_EN Only from PLD, used to enable closed loop trimming of all TrimCells together.

Next to each DC-DC converter, four voltages are shown. These voltages correspond to the operating voltage profile of the Margin/Trim Block.

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When the VPS[1:0] = 00, representing Voltage Profile 0: (Voltage Profile 0 is recommended to be used for the normal circuit operation)

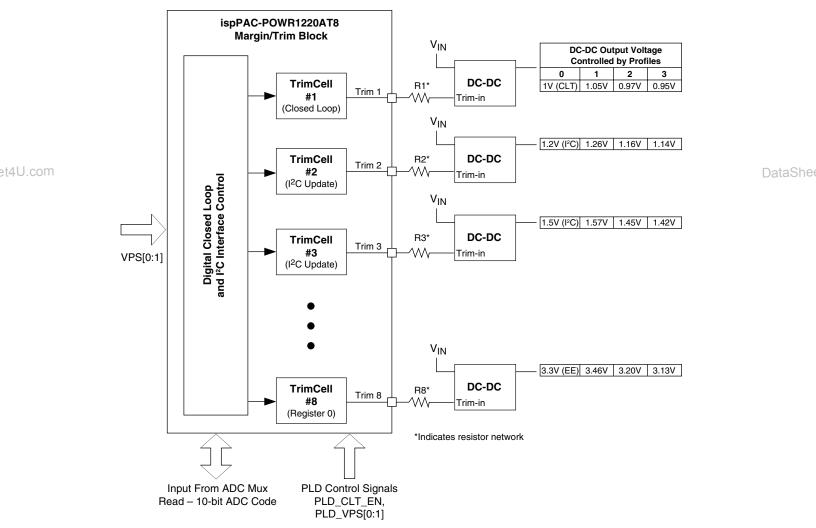
The output voltage of the DC-DC converter controlled by the Trim 1 pin of the ispPAC-POWR1220AT8 will be 1V and that TrimCell is operating in closed loop trim mode. At the same time, the DC-DC converters controlled by Trim 2, Trim 3 and Trim 8 pins output 1.2V, 1.5V and 3.3V respectively.

When the VPS[1:0] = 01, representing Voltage Profile 1 being active:

The DC-DC output voltage controlled by Trim 1, 2, 3, and 8 pins will be 1.05V, 1.26V, 1.57V, and 3.46V. These supply voltages correspond to 5% above their respective normal operating voltage (also called as margin high).

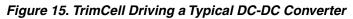
Similarly, when VPS[1:0] = 11, all DC-DC converters are margined low by 5%.

Figure 14. ispPAC-POWR1220AT8 Trim and Margin Block



There are eight TrimCells in the ispPAC-POWR1220AT8 device, enabling simultaneous control of up to eight individual power supplies. Each TrimCell can generate up to four trimming voltages to control the output voltage of the DC-DC converter.

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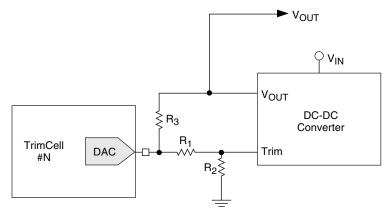


Figure 15 shows the resistor network between the TrimCell #N in the ispPAC-POWR1220AT8 and the DC-DC converter. The values of these resistors depend on the type of DC-DC converter used and its operating voltage range. The method to calculate the values of the resistors R1, R2, and R3 are described in a separate application note.

Voltage Profile Control

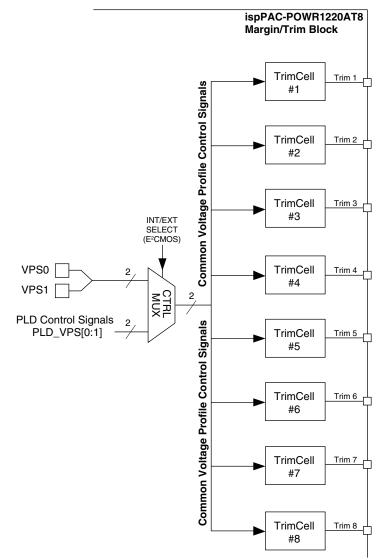
The Margin / Trim Block of ispPAC-POWR1220AT8 consists of eight TrimCells. Because all eight TrimCells in the Margin / Trim Block are controlled by two common voltage profile control signals, they all operate at the same voltage profile. These common voltage profile control signals are derived from a Control Multiplexer. One set of voltage profile control inputs to the control multiplexer is from a pair of device pins: VPS0, VPS1. The second set of voltage profile control signals is from the PLD: PLD_VPS0, PLD_VPS1. The selection between the two sets of voltage profile control signals is programmable and is stored in the E²CMOS memory.

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Figure 16. Voltage Profile Control

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TrimCell Architecture

The TrimCell block diagram is shown in Figure 17. The 8-bit DAC at the output provides the trimming voltage required to set the output voltage of a programmable supply. Each TrimCell can be operated in any one of the four voltage profiles. In each voltage profile the output trimming voltage can be set to a preset value. There are six 8-bit registers in each TrimCell that, depending on the operational mode, set the DAC value. Of these, four DAC values (DAC Register 0 to DAC Register 3) are stored in the E²CMOS memory while the remaining register contents are stored in volatile registers. Two multiplexers (Mode Mux and Profile Mux) control the routing of the code to the DAC. The Profile Mux can be controlled by common TrimCell voltage profile control signals.

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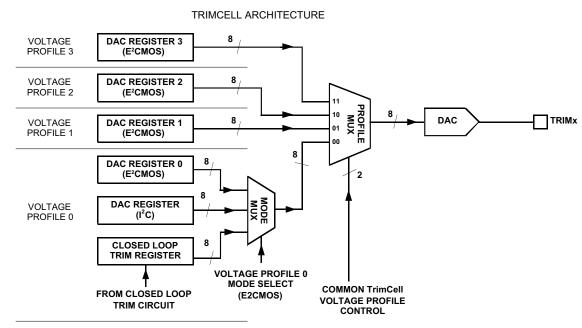


Figure 17. ispPAC-POWR1220AT8 Output TrimCell

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Figure 14 shows four power supply voltages next to each DC-DC converter. When the Profile MUX is set to Voltage Profile 3, the DC supply controlled by Trim 1 will be at 0.95V, the DC supply controlled by Trim 2 will be at 1.14V, 1.43V for Trim 3 and 3.14V for Trim 8. When Voltage Profile 0 is selected, Trim 1 will set the supply to 1V, Trim 2 and Trim 3 will be set by the values that have been loaded using I²C at 1.2 and 1.5V, and Trim 8 will be set to 3.3V. DataSheet4U.com

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The following table summarizes the voltage profile selection and the corresponding DAC output trimming voltage. The voltage profile selection is common to all eight TrimCells.

Table 6. TrimCell Voltage Profile and Operating Modes

| PLD_VPS[1:0] or VPS[1:0] | Selected Voltage Profile | Selected Mode | Trimming Voltage is Controlled by |
|-----------------------------|--------------------------|--------------------------------------|--------------------------------------|
| 11 | Voltage Profile 3 | — | DAC Register 3 (E ² CMOS) |
| 10 | Voltage Profile 2 | | DAC Register 2 (E ² CMOS) |
| 01 | Voltage Profile 1 | | DAC Register 1 (E ² CMOS) |
| | | DAC Register 0 Select | DAC Register 0 (E ² CMOS) |
| 00 | Voltage Profile 0 | DAC Register I ² C Select | DAC Register (I ² C) |
| | | Digital Closed Loop Trim | Closed Loop Trim Register |

TrimCell Operation in Voltage Profiles 1, 2 and 3: The output trimming voltage is determined by the code stored in the DAC Registers 1, 2, and 3 corresponding to the selected Voltage Profile.

TrimCell Operation in Voltage Profile 0: The Voltage Profile 0 has three operating modes. They are DAC Register 0 Select mode, DAC Register I²C Select mode and Closed Loop Trim mode. The mode selection is stored in the E²CMOS configuration memory. Each of the eight TrimCells can be independently set to different operating modes during Voltage Profile 0 mode of operation.

DAC Register 0 Select Mode: The contents of DAC register 0 are stored in the on-chip E²CMOS memory. When Voltage Profile 0 is selected, the DAC will be loaded with the value stored in DAC Register 0.

DAC Register I²C Select Mode: This mode is used if the power management arrangement requires an external microcontroller to control the DC-DC converter output voltage. The microcontroller updates the contents of the DAC

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Register I²C on the fly to set the trimming voltage to a desired value. The DAC Register I²C is a volatile register and is reset to 80H (DAC at Bipolar zero) upon power-on. The external microcontroller writes the correct DAC code in this DAC Register I²C before enabling the programmable power supply.

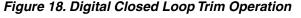
Digital Closed Loop Trim Mode

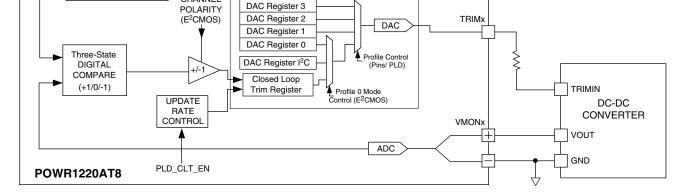
Closed loop trim mode operation can be used when tight control over the DC-DC converter output voltage at a desired value is required. The closed loop trim mechanism operates by comparing the measured output voltage of the DC-DC converter with the internally stored voltage setpoint. The difference between the setpoint and the actual DC-DC converter voltage generates an error voltage. This error voltage adjusts the DC-DC converter output voltage toward the setpoint. This operation iterates until the setpoint and the DC-DC converter voltage are equal.

Figure 18 shows the closed loop trim operation of a TrimCell. At regular intervals (as determined by the Update Rate Control register) the ispPAC-POWR1220AT8 device initiates the closed loop power supply voltage correction cycle through the following blocks:

- Non-volatile Setpoint register stores the desired output voltage
- On-chip ADC is used to measure the voltage of the DC-DC converter
- Three-state comparator is used to compare the measured voltage from the ADC with the Setpoint register contents. The output of the three state comparator can be one of the following:
 - +1 if the setpoint voltage is greater than the DC-DC converter voltage
 - -1 if the setpoint voltage is less than the DC-DC converter voltage
 - 0 if the setpoint voltage is equal to the DC-DC converter voltage
- Channel polarity control determines the polarity of the error signal
- Closed loop trim register is used to compute and store the DAC code corresponding to the error voltage. The contents of the Closed Loop Trim will be incremented or decremented depending on the channel polarity and the three-state comparator output. If the three-state comparator output is 0, the closed loop trim register contents are left unchanged.
- The DAC in the TrimCell is used to generate the analog error voltage that adjusts the attached DC-DC converter output voltage.

SETPOINT (E²CMOS) E²CMOS Registers TRIM CELL CHANNEL





The closed loop trim cycle interval is programmable and is set by the update rate control register. The following table lists the programmable update interval that can be selected by the update rate register.

Table 7. Output DAC Update Rate in Digital Closed Loop Mode

| Update Rate Control Value | Update Interval |
|------------------------------|--------------------|
| 00 | 580 µs |
| 01 | 1.15 ms |
| 10 | 9.22 ms |
| 11 | 18.5 ms |

There is a one-to-one relationship between the selected TrimCell and the corresponding VMON input for the closed loop operation. For example, if TrimCell 3 is used to control the power supply in the closed loop trim mode, VMON3 must be used to monitor its output power supply voltage.

The closed loop operation can only be started by activating the internally generated PLD signal, called PLD_CLT_EN, in PAC-Designer software. The selection of Voltage Profile 0, however, can be either through the pins VPS0, VPS1 or through the PLD signals PLDVPS0 and PLDVPS1.

Closed Loop Start-up Behavior

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The contents of the closed loop register, upon power-up, will contain a value 80h (Bipolar-zero) value. The DAC output voltage will be equal to the programmed Offset voltage. Usually under this condition, the power supply output will be close to its nominal voltage. If the power supply trimming should start after reaching its desired output voltage, the corresponding DAC code can be loaded into the closed loop trim register through I²C (same address as the DAC register I²C mode) before activating the PLD_CLT_EN signal.

Details of the Digital to Analog Converter (DAC)

Each trim cell has an 8-bit bipolar DAC to set the trimming voltage (Figure 19). The full-scale output voltage of the DAC is +/- 320 mV. A code of 80H results in the DAC output set at its bi-polar zero value.

The voltage output from the DAC is added to a programmable offset value and the resultant voltage is then applied to the trim output pin. The offset voltage is typically selected to be approximately equal to the DC-DC converter open circuit trim node voltage. This results in maximizing the DC-DC converter output voltage range.

The programmed offset value can be set to 0.6V, 0.8V, 1.0V or 1.25V. This value selection is stored in E²CMOS memory and cannot be changed dynamically.

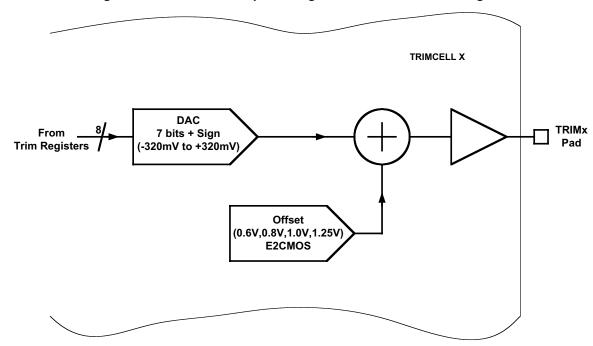


Figure 19. Offset Voltage is Added to DAC Output Voltage to Derive Trim Pad Voltage

RESETb Signal, RESET Command via JTAG or I²C

Activating the RESETb signal (Logic 0 applied to the RESETb pin) or issuing a reset instruction via JTAG or I²C will force the outputs to the following states independent of how these outputs have been configured in the PINS window:

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- OUT5-20 will go high-impedance.
- HVOUT pins programmed for open drain operation will go high-impedance.
- HVOUT pins programmed for FET driver mode operation will pull down.

At the conclusion of the RESET event, these outputs will go to the states defined by the PINS window, and if a sequence has been programmed into the device, it will be re-started at the first step. The analog calibration will be re-done and consequently, the VMONs, ADCs, and DACs will not be operational until 2.5 milliseconds (max.) after the conclusion of the RESET event.

CAUTION: Activating the RESETb signal or issuing a RESET command through I2C or JTAG during the ispPAC-POWR1220AT8 device operation, results in the device aborting all operations and returning to the power-on reset state. The status of the power supplies which are being enabled by the ispPAC-POWR1220AT8 will be determined by the state of the outputs shown above.

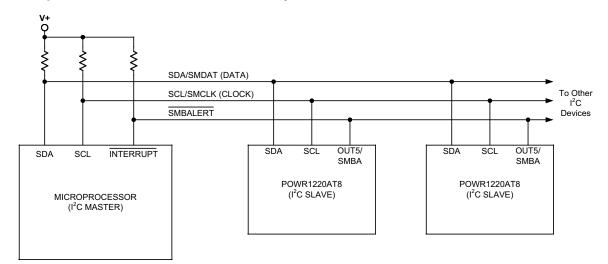
I²C/SMBUS Interface

I²C and SMBus are low-speed serial interface protocols designed to enable communications among a number of devices on a circuit board. The ispPAC-POWR1220AT8 supports a 7-bit addressing of the I²C communications protocol, as well as SMBTimeout and SMBAlert features of the SMBus, enabling it to easily integrated into many types of modern power management systems. Figure 20 shows a typical I²C configuration, in which one or more ispPAC-POWR1220AT8s are slaved to a supervisory microcontroller. SDA is used to carry data signals, while SCL provides a synchronous clock signal. The SMBAlert line is only present in SMBus systems. The 7-bit I²C address of the POWR1220AT8 is fully programmable through the JTAG port.

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Figure 20. ispPAC-POWR1220AT8 in I²C/SMBUS System



In both the I²C and SMBus protocols, the bus is controlled by a single MASTER device at any given time. This master device generates the SCL clock signal and coordinates all data transfers to and from a number of slave devices. The ispPAC-POWR1220AT8 is configured as a slave device, and cannot independently coordinate data transfers. Each slave device on a given I²C bus is assigned a unique address. The ispPAC-POWR1220AT8 implements the 7bit addressing portion of the standard. Any 7-bit address can be assigned to the ispPAC-POWR1220AT8 device by programming through JTAG. When selecting a device address, one should note that several addresses are reserved by the I²C and/or SMBus standards, and should not be assigned to ispPAC-POWR1220AT8 devices to assure bus compatibility. Table 8 lists these reserved addresses.

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Table 8. I²C/SMBus Reserved Slave Device Addresses

| Address | R/W bit | I ² C function Description | SMBus Function | |
|----------|---------|---------------------------------------|------------------------------|--|
| 0000 000 | 0 | General Call Address | General Call Address | |
| 0000 000 | 1 | Start Byte | Start Byte | |
| 0000 001 | х | CBUS Address | CBUS Address | |
| 0000 010 | х | Reserved | Reserved | |
| 0000 011 | х | Reserved | Reserved | |
| 0000 1xx | х | HS-mode master code | HS-mode master code | |
| 0001 000 | х | NA | SMBus Host | |
| 0001 100 | х | NA | SMBus Alert Response Address | |
| 0101 000 | х | NA | Reserved for ACCESS.bus | |
| 0110 111 | х | NA | Reserved for ACCESS.bus | |
| 1100 001 | х | NA | SMBus Device Default Address | |
| 1111 0xx | х | 10-bit addressing | 10-bit addressing | |
| 1111 1xx | х | Reserved Reserved | | |

The ispPAC-POWR1220AT8's I²C/SMBus interface allows data to be both written to and read from the device. A data write transaction (Figure 21) consists of the following operations:

1. Start the bus transaction

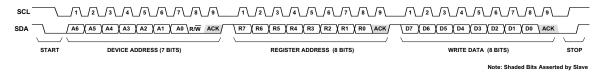
- 2. Transmit the device address (7 bits) along with a low write bit
- 3. Transmit the address of the register to be written to (8 bits)
- 4. Transmit the data to be written (8 bits)
- 5. Stop the bus transaction

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To start the transaction, the master device holds the SCL line high while pulling SDA low. Address and data bits are then transferred on each successive SCL pulse, in three consecutive byte frames of 9 SCL pulses. Address and data are transferred on the first 8 SCL clocks in each frame, while an acknowledge signal is asserted by the slave device on the 9th clock in each frame. Both data and addresses are transferred in a most-significant-bit-first format. The first frame contains the 7-bit device address, with bit 8 held low to indicate a write operation. The second frame contains the register address to which data will be written, and the final frame contains the actual data to be written. Note that the SDA signal is only allowed to change when the SCL is low, as raising SDA when SCL is high signals the end of the transaction.

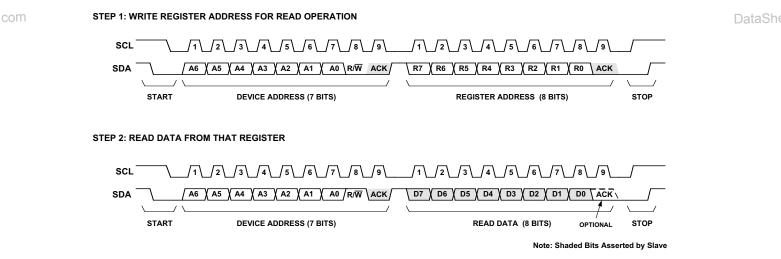
Figure 21. I²C Write Operation

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Reading a data byte from the ispPAC-POWR1220AT8 requires two separate bus transactions (Figure 22). The first transaction writes the register address from which a data byte is to be read. Note that since no data is being written to the device, the transaction is concluded after the second byte frame. The second transaction performs the actual read. The first frame contains the 7-bit device address with the R/W bit held High. In the second frame the ispPAC-POWR1220AT8 asserts data out on the bus in response to the SCL signal. Note that the acknowledge signal in the second frame is asserted by the master device and not the ispPAC-POWR1220AT8.

Figure 22. I²C Read Operation



The ispPAC-POWR1220AT8 provides 26 registers that can be accessed through its I²C interface. These registers provide the user with the ability to monitor and control the device's inputs and outputs, and transfer data to and from the device. Table provides a summary of these registers.

| Register Address | Register Name | Read/Write | Description | Value on POR, RESET |
|------------------|----------------|------------|------------------------------------|---------------------|
| 0x00 | vmon_status0 | R | VMON input status Vmon[4:1] | 1010 1010 |
| 0x01 | vmon_status1 | R | VMON input status Vmon[8:5] | 1010 1010 |
| 0x02 | vmon_status2 | R | VMON input status Vmon[12:9] | 1010 1010 |
| 0x03 | output_status0 | R | Output status HVOUT[4:1], OUT[8:5] | 0000 0000 |
| 0x04 | output_status1 | R | Output status OUT[16:9] | 0000 0000 |
| 0x05 | output_status2 | R | Output status OUT[20:17] | 1111 0000 |

Table 9. I²C Control Registers

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| Register Address | Register Name | Read/Write | Description | Value on POR, RESET |
|------------------|----------------|------------|-----------------------------|---------------------|
| 0x06 | input_status | R | Input status IN[6:1] | 1100 0000 |
| 0x07 | adc_value_low | R | ADC D[3:0] and status | 0000 1110 |
| 0x08 | adc_value_high | R | ADC D[11:4] | 0000 0000 |
| 0x09 | adc_mux | R/W | ADC Attenuator and MUX[3:0] | 1110 0000 |
| 0x0A | UES_byte0 | R | UES[7:0] | EEEE EEEE |
| 0x0B | UES_byte1 | R | UES[15:8] | EEEE EEEE |
| 0x0C | UES_byte2 | R | UES[23:16] | EEEE EEEE |
| 0x0D | UES_byte3 | R | UES[31:24] | EEEE EEEE |
| 0x0E | gp_output1 | R/W | GPOUT[8:1] | 1000 0000 |
| 0x0F | gp_output2 | R/W | GPOUT[16:9] | 0000 0000 |
| 0x10 | gp_output3 | R/W | GPOUT[20:17] | 1111 0000 |
| 0x11 | input_value | R/W | PLD Input State [5:2] | 1100 0001 |
| 0x12 | reset | W | Resets device on write | 1111 1111 |
| 0x13 | trim1_trim | R/W | Trim DAC 1 [7:0] | 1000 0000 |
| 0x14 | trim2_trim | R/W | Trim DAC 2 [7:0] | 1000 0000 |
| 0x15 | trim3_trim | R/W | Trim DAC 3 [7:0] | 1000 0000 |
| 0x16 | trim4_trim | R/W | Trim DAC 4 [7:0] | 1000 0000 |
| 0x17 | trim5_trim | R/W | Trim DAC 5 [7:0] | 1000 0000 |
| 0x18 | trim6_trim | R/W | Trim DAC 6 [7:0] | 1000 0000 |
| 0x19 | trim7_trim | R/W | Trim DAC 7 [7:0] | 1000 0000 |
| 0x1A | trim8_trim | R/W Data | Trim DAC 8 [7:0] | 1000 0000 |

Table 9. I²C Control Registers (Cont.)

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Note: x = unknown, 0=low, 1=high, E-E² memory setting (UES string)

Several registers are provided for monitoring the status of the analog inputs. The three registers VMON_STATUS[0:2] provide the ability to read the status of the VMON output comparators. The ability to read both the 'a' and 'b' comparators from each VMON input is provided through the VMON input registers. Note that if a VMON input is configured to window comparison mode, then the corresponding VMONxA register bit will reflect the status of the window comparison.

Figure 23. VMON Status Registers

0x00 - VMON_STATUS0 (Read Only)

| VMON4B | VMON4A | VMON3B | VMON3A | VMON2B | VMON2A | VMON1B | VMON1A |
|--------|--------|--------|--------|--------|--------|--------|--------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x01 - VMON_STATUS1 (Read Only)

| VMON8B | VMON8A | VMON7B | VMON7A | VMON6B | VMON6A | VMON5B | VMON5A |
|--------|--------|--------|--------|--------|--------|--------|--------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x02 - VMON_STATUS2 (Read Only)

| VMON12B | VMON12A | VMON11B | VMON11A | VMON10B | VMON10A | VMON9B | VMON9A |
|---------|---------|---------|---------|---------|---------|--------|--------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

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It is also possible to directly read the value of the voltage present on any of the VMON inputs by using the ispPAC-POWR1220AT8's ADC. Three registers provide the I²C interface to the ADC (Figure 23).

Figure 24. ADC Interface Registers

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0x07 - ADC_VALUE_LOW (Read Only)

| D3 | D2 | D1 | D0 | 1 | 1 | 1 | DONE |
|----|----|----|----|----|----|----|------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x08 - ADC_VALUE_HIGH (Read Only)

| D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 |
|-----|-----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x09 - ADC_MUX (Read/Write)

| x | x | х | ATTEN | SEL3 | SEL2 | SEL1 | SEL0 |
|----|----|----|-------|------|------|------|------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

To perform an A/D conversion, one must set the input attenuator and channel selector. Two input ranges may be set using the attenuator, 0 - 2.048V and 0 - 6.144V. Table 10 shows the input attenuator settings.

Table 10. ADC Input Attenuator Control

| ATTEN (ADC_MUX.4) | Resolution | Full-Scale Range |
|-------------------|-----------------|------------------|
| 0 | DataSh2mV4U.com | 2.048 V |
| 1 | 6mV | 6.144 V |

The input selector may be set to monitor any one of the twelve VMON inputs, the VCCA input, or the VCCINP input. Table 11 shows the codes associated with each input selection.

Table 11. V_{MON} Address Selection Table

| | Select | t Word | | |
|---------------------|---------------------|---------------------|---------------------|---------------|
| SEL3 (ADC_MUX.3) | SEL2 (ADC_MUX.2) | SEL1 (ADC_MUX.1) | SEL0 (ADC_MUX.0) | Input Channel |
| 0 | 0 | 0 | 0 | VMON1 |
| 0 | 0 | 0 | 1 | VMON2 |
| 0 | 0 | 1 | 0 | VMON3 |
| 0 | 0 | 1 | 1 | VMON4 |
| 0 | 1 | 0 | 0 | VMON5 |
| 0 | 1 | 0 | 1 | VMON6 |
| 0 | 1 | 1 | 0 | VMON7 |
| 0 | 1 | 1 | 1 | VMON8 |
| 1 | 0 | 0 | 0 | VMON9 |
| 1 | 0 | 0 | 1 | VMON10 |
| 1 | 0 | 1 | 0 | VMON11 |
| 1 | 0 | 1 | 1 | VMON12 |
| 1 | 1 | 0 | 0 | VCCA |
| 1 | 1 | 0 | 1 | VCCINP |

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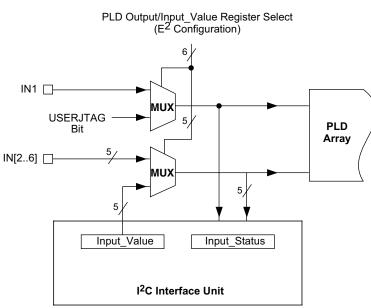
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Writing a value to the ADC_MUX register to set the input attenuator and selector will automatically initiate a conversion. When the conversion is in process, the DONE bit (ADC_VALUE_LOW.0) will be reset to 0. When the conversion is complete, this bit will be set to 1. When the conversion is complete (DONE bit is set to 1), the result may be read out of the ADC by performing two I²C read operations; one for ADC_VALUE_LOW, and one for ADC_VALUE_HIGH. It is recommended that the I²C master load a second conversion command only after the completion of the current conversion command (Waiting for the DONE bit to be set to 1).

If an I²C request is placed before the current conversion is complete, the DONE bit will be set to 1 only after the second request is complete.

The status of the digital input lines may also be monitored and controlled through I²C commands. Figure 25 shows the I²C interface to the IN[1:6] digital input lines. The input status may be monitored by reading the INPUT_STATUS register, while input values to the PLD array may be set by writing to the INPUT_VALUE register. To be able to set an input value for the PLD array, the input multiplexer associated with that bit needs to be set to the I²C register setting in E²CMOS memory otherwise the PLD will receive its input from the INx pin.

Figure 25. I²C Digital Input Interface



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0x06 - INPUT_STATUS (Read Only)



0x11 - INPUT_VALUE (Read/Write)

| х | х | 16 | 15 | 14 | 13 | 12 | х |
|----|----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

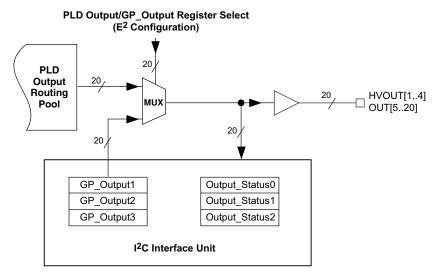
The digital outputs may also be monitored and controlled through the I²C interface, as shown in Figure 26. The status of any given digital output may be read by reading the contents of the associated OUTPUT_STATUS[2:0] register. Note that in the case of the outputs, the status reflected by these registers reflects the logic signal used to drive the pin, and does not sample the actual level present on the output pin. For example, if an output is set high but is not pulled up, the output status bit corresponding with that pin will read '1', but a high output signal will not appear on the pin.

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Digital outputs may also be optionally controlled directly by the I²C bus instead of by the PLD array. The outputs may be driven either from the PLD ORP or from the contents of the GP_OUTPUT[2:0] registers with the choice user-settable in E²CMOS memory. Each output may be independently set to output from the PLD or from the GP_OUTPUT registers.

Figure 26. I²C Output Monitor and Control Logic

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0x03 - OUTPUT_STATUS0 (Read Only)

| OUT8 | OUT7 | OUT6 | OUT5 | HVOUT4 | HVOUT3 | HVOUT2 | HVOUT1 |
|------|------|------|------|--------|--------|--------|--------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x04 - OUTPUT_STATUS1 (Read Only)

| OUT16 | OUT15 | OUT14 | OUT13 | OUT12 | OUT11 | OUT10 | OUT9 |
|-------|-------|-------|-------|-------|-------|-------|------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x05 - OUTPUT_STATUS2 (Read Only)

| х | x | х | х | OUT20 | OUT19 | OUT18 | OUT17 |
|----|----|----|----|-------|-------|-------|-------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x0E - GP_OUTPUT1 (Read/Write)

| GP8 | GP7 | GP6 | GP5_ENb | GP4 | GP3 | GP2 | GP1 |
|-----|-----|-----|---------|-----|-----|-----|-----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x0F - GP_OUTPUT2 (Read/Write)

| GP16 | GP15 | GP14 | GP13 | GP12 | GP11 | GP10 | GP9 |
|------|------|------|------|------|------|------|-----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x10 - GP_OUTPUT3 (Read/Write)

| х | х | х | х | GP20 | GP19 | GP18 | GP17 |
|----|----|----|----|------|------|------|------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

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The UES word may also be read through the I²C interface, with the register mapping shown in Figure 27.

Figure 27. I²C Register Mapping for UES Bits

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| UES7 | UES6 | UES5 | UES4 | UES3 | UES2 | UES1 | UES0 |
|------|------|------|------|------|------|------|------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x0B - UES_BYTE1 (Read Only)

0x0A - UES_BYTE0 (Read Only)

| | UES15 | UES14 | UES13 | UES12 | UES11 | UES10 | UES9 | UES8 |
|---|-------|-------|-------|-------|-------|-------|------|------|
| - | b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x0C - UES_BYTE2 (Read Only)

| UES23 | UES22 | UES21 | UES20 | UES19 | UES18 | UES17 | UES16 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x0D - UES_BYTE3 (Read Only)

| UES31 | UES30 | UES29 | UES28 | UES27 | UES26 | UES25 | UES24 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

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The I²C interface also provides the ability to initiate reset operations. The ispPAC-POWR1220AT8 may be reset by issuing a write of any value to the I²C RESET register (Figure 28). Note: The execution of the I²C reset command is equivalent to toggling the Resetb pin of the chip. Refer to the Resetb Signal, RESET Command via JTAG or I²C section of this data sheet for further information.

Figure 28. I²C Reset Register

0x12 - RESET (Write Only)



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The ispPAC-POWR1220AT8 also provides the user with the ability to program the trim values over the I²C interface, by writing the appropriate binary word to the associated trim register (Figure 29).

Figure 29. I²C Trim Registers

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0x13 - TRIM1_TRIM (Read/Write)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|----|----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x14 - TRIM2_TRIM (Read/Write)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|----|----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x15 - TRIM3_TRIM (Read/Write)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|----|----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x16 - TRIM4_TRIM (Read/Write)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|----|----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

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0x17 - TRIM5_TRIM (Read/Write)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|----|----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x18 - TRIM6_TRIM (Read/Write)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|----|----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

0x19 - TRIM7_TRIM (Read/Write)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|----|----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

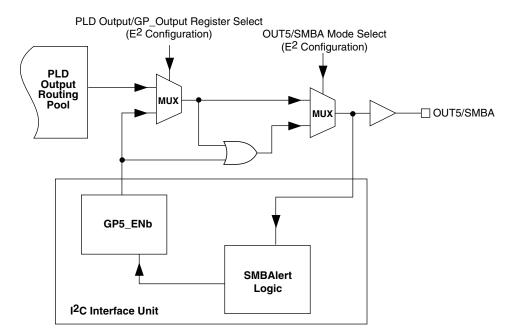
0x1A - TRIM8_TRIM (Read/Write)

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|----|----|----|----|----|----|----|----|
| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 |

SMBus SMBAlert Function

The ispPAC-POWR1220AT8 provides an SMBus SMBAlert function so that it can request service from the bus master when it is used as part of an SMBus system. This feature is supported as an alternate function of OUT5. When the SMBAlert feature is enabled, OUT5 is controlled by a combination of the PLD ORP and the GP5_ENb bit (Figure 30). Note: To enable the SMBAlert feature, the SMB_Mode (EECMOS bit) should be set in software.

Figure 30. ispPAC-POWR1220AT8 SMBAlert Logic

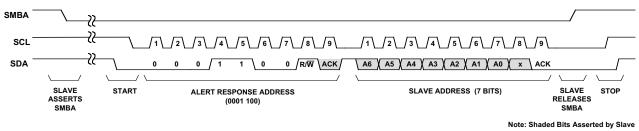


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The typical flow for an SMBAlert transaction is as follows (Figure 30):

- 1. GP5_ENb bit is forced (Via I²C write) to Low
- 2. ispPAC-POWR1220AT8 PLD Logic pulls OUT5/SMBA Low
- 3. Master responds to interrupt from SMBA line
- 4. Master broadcasts a read operation using the SMBus Alert Response Address (ARA)
- 5. ispPAC-POWR1220AT8 responds to read request by transmitting its device address
- 6. If transmitted device address matches ispPAC-POWR1220AT8 address, it sets GP5_ENb bit high. This releases OUT5/SMBA.





After OUT5/SMBA has been released, the bus master (typically a microcontroller) may opt to perform some service functions in which it may send data to or read data from the ispPAC-POWR1220AT8. As part of the service functions, the bus master will typically need to clear whatever condition initiated the SMBAlert request, and will also need to reset GP5_ENb to re-enable the SMBAlert function. For further information on the SMBus, the user should consult the SMBus Standard.

Designs using the SMBAlert feature are required to set the device's I^2C/SMB us address to the lowest of all the addresses on that I^2C/SMB us.

Software-Based Design Environment

Designers can configure the ispPAC-POWR1220AT8 using PAC-Designer, an easy to use, Microsoft Windows compatible program. Circuit designs are entered graphically and then verified, all within the PAC-Designer environment. Full device programming is supported using PC parallel port I/O operations and a download cable connected to the serial programming interface pins of the ispPAC-POWR1220AT8. A library of configurations is included with basic solutions and examples of advanced circuit techniques are available on the Lattice web site for downloading. In addition, comprehensive on-line and printed documentation is provided that covers all aspects of PAC-Designer operation. The PAC-Designer schematic window, shown in Figure 32, provides access to all configurable ispPAC-POWR1220AT8 elements via its graphical user interface. All analog input and output pins are represented. Static or non-configurable pins such as power, ground, and the serial digital interface are omitted for clarity. Any element in the schematic window can be accessed via mouse operations as well as menu commands. When completed, configurations can be saved, simulated, and downloaded to devices.

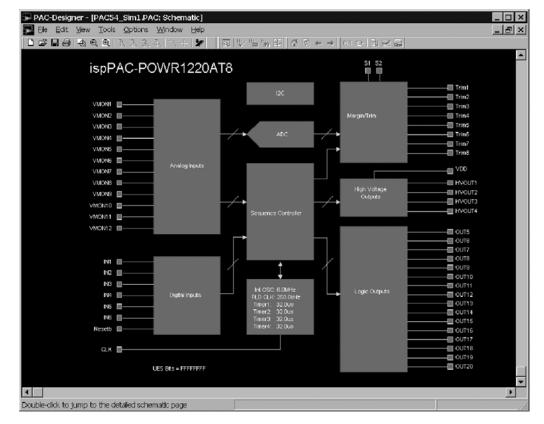


Figure 32. PAC-Designer ispPAC-POWR1220AT8 Design Entry Screen

In-System Programming

The ispPAC-POWR1220AT8 is an in-system programmable device. This is accomplished by integrating all E² configuration memory and SRAM control logic on-chip. Programming is performed through a 4-wire, IEEE 1149.1 compliant serial JTAG interface at normal logic levels. Once a device is programmed, all configuration information is stored on-chip, in non-volatile E²CMOS memory cells. The specifics of the IEEE 1149.1 serial interface and all isp-PAC-POWR1220AT8 instructions are described in the JTAG interface section of this data sheet.

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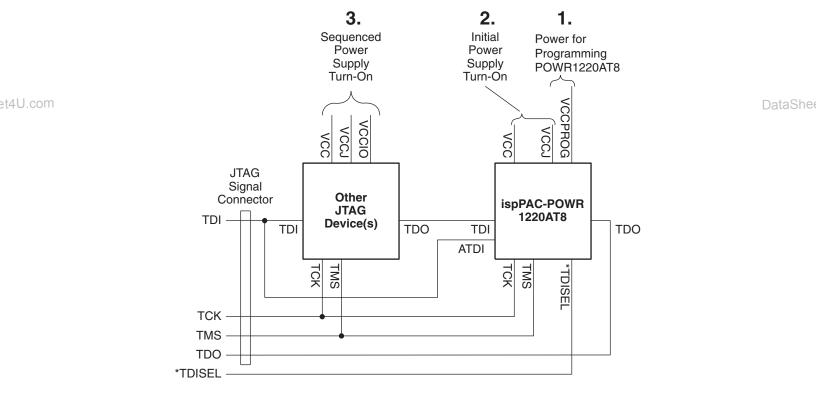
Programming ispPAC-POWR1220AT8: Alternate Method

Some applications require that the ispPAC-POWR1220AT8 be programmed before turning the power on to the entire circuit board. To meet such application needs, the ispPAC-POWR1220AT8 provides an alternate programming method which enables the programming of the ispPAC-POWR1220AT8 device through the JTAG chain with a separate power supply applied just to the programming section of the ispPAC-POWR1220AT8 device with the main power supply of the board turned off.

Three special purpose pins, VCCPROG, ATDI and TDISEL, enable programming of the un-programmed ispPAC-POWR1220AT8 under such circumstances. The VCCPROG pin powers just the programming circuitry of the isp-PAC-POWR1220AT8 device. The ATDI pin provides an alternate connection to the JTAG header while bypassing all the un-powered devices in the JTAG chain. TDISEL pin enables switching between the ATDI and the standard JTAG signal TDI. When the internally pulled-up TDISEL = 1, standard TDI pin is enabled and when the TDISEL = 0, ATDI is enabled.

In order to use this feature the JTAG signals of the ispPAC-POWR1220AT8 are connected to the header as shown in figure 32. Note: The ispPAC-POWR1220AT8 should be the last device in the JTAG chain.

Figure 33. ispPAC-POWR1220AT8 Alternate TDI Configuration Diagram



Alternate TDI Selection Via JTAG Command

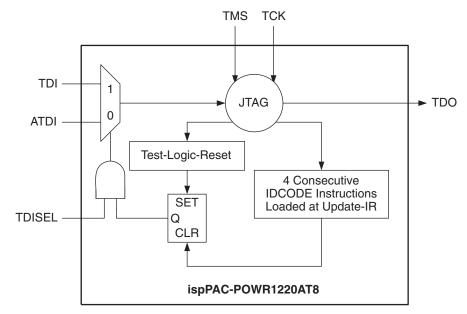
When the TDISEL pin held high and four consecutive IDCODE instructions are issued, ispPAC-POWR1220AT8 responds by making its active JTAG data input the ATDI pin. When ATDI is selected, data on its TDI pin is ignored until the JTAG state machine returns to the Test-Logic-Reset state.

This method of selecting ATDI takes advantage of the fact that a JTAG device with an IDCODE register will automatically load its unique IDCODE instruction into the Instruction Register after a Test-Logic-Reset. This JTAG capability permits blind interrogation of devices so that their location in a serial chain can be identified without having to know anything about them in advance. A blind interrogation can be made using only the TMS and TCLK control

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pins, which means TDI and TDO are not required for performing the operation. Figure 34 illustrates the logic for selecting whether the TDI or ATDI pin is the active data input to ispPAC-POWR1220AT8.

Figure 34. ispPAC-POWR1220AT8 TDI/ATDI Pin Selection Diagram



t4U.com Table 12 shows in truth table form the same conditions required to select either TDI or ATDI as in the logic diagram DataSho found in Figure 34.

Table 12. ispPAC-POWR1220AT8 ATDI/TDI Selection Table

| TDISEL Pin | JTAG State Machine Test-Logic-Reset | 4 Consecutive IDCODE Commands Loaded at Update-IR | Active JTAG Data Input Pin |
|------------|--|---|-------------------------------|
| Н | No | Yes | ATDI (TDI Disabled) |
| Н | Yes | No | TDI (ATDI Disabled) |
| L | Х | Х | ATDI (TDI Disabled) |

Please refer to the Lattice application note AN6068, *Programming the ispPAC-POWR122AT8 in a JTAG Chain Using ATDI*. The application note includes specific SVF code examples and information on the use of Lattice design tools to verify device operation in alternate TDI mode.

VCCPROG Power Supply Pin

Because the VCCPROG pin directly powers the on-chip programming circuitry, the ispPAC-POWR1220AT8 device can be programmed by applying power to the VCCPROG pin (without powering the entire chip though the VCCD and VCCA pins). In addition, to enable the on-chip JTAG interface circuitry, power should be applied to the VCCJ pin.

When the ispPAC-POWR1220AT8 is using the VCCPROG pin, its VCCD and VCCA pins can be open or pulled low. Additionally, other than JTAG I/O pins, all digital output pins are in Hi-Z state, HVOUT pins configured as MOSFET driver are driven low, and all other inputs are ignored.

To switch the power supply back to VCCD and VCCA pins, one should turn the VCCPROG supply and VCCJ off before turning the regular supplies on.

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User Electronic Signature

A user electronic signature (UES) feature is included in the E²CMOS memory of the ispPAC-POWR1220AT8. This consists of 32 bits that can be configured by the user to store unique data such as ID codes, revision numbers or inventory control data. The specifics of this feature are discussed in the IEEE 1149.1 serial interface section of this data sheet.

Electronic Security

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An electronic security "fuse" (ESF) bit is provided in every ispPAC-POWR1220AT8 device to prevent unauthorized readout of the E²CMOS configuration bit patterns. Once programmed, this cell prevents further access to the functional user bits in the device. This cell can only be erased by reprogramming the device, so the original configuration cannot be examined once programmed. Usage of this feature is optional. The specifics of this feature are discussed in the IEEE 1149.1 serial interface section of this data sheet.

Production Programming Support

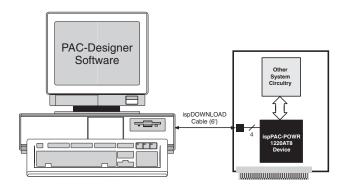
Once a final configuration is determined, an ASCII format JEDEC file can be created using the PAC-Designer software. Devices can then be ordered through the usual supply channels with the user's specific configuration already preloaded into the devices. By virtue of its standard interface, compatibility is maintained with existing production programming equipment, giving customers a wide degree of freedom and flexibility in production planning.

Evaluation Fixture

Included in the basic ispPAC-POWR1220AT8 Design Kit is an engineering prototype board that can be connected to the parallel port of a PC using a Lattice download cable. It demonstrates proper layout techniques for the isp-PAC-POWR1220AT8 and can be used in real time to check circuit operation as part of the design process. Input and output connections are provided to aid in the evaluation of the ispPAC-POWR1220AT8 for a given application. (Figure 35). DataSheet4U.com

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Figure 35. Download from a PC



IEEE Standard 1149.1 Interface (JTAG)

Serial Port Programming Interface Communication with the ispPAC-POWR1220AT8 is facilitated via an IEEE 1149.1 test access port (TAP). It is used by the ispPAC-POWR1220AT8 as a serial programming interface. A brief description of the ispPAC-POWR1220AT8 JTAG interface follows. For complete details of the reference specification, refer to the publication, Standard Test Access Port and Boundary-Scan Architecture, IEEE Std 1149.1-1990 (which now includes IEEE Std 1149.1a-1993).

Overview

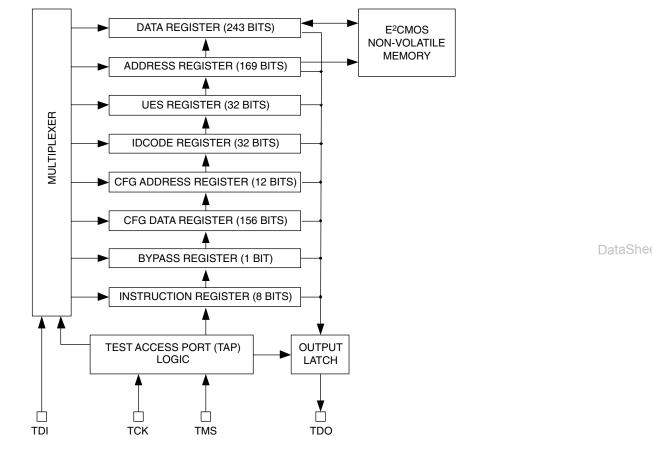
An IEEE 1149.1 test access port (TAP) provides the control interface for serially accessing the digital I/O of the isp-PAC-POWR1220AT8. The TAP controller is a state machine driven with mode and clock inputs. Given in the correct sequence, instructions are shifted into an instruction register, which then determines subsequent data input, data output, and related operations. Device programming is performed by addressing the configuration register, shifting U.com

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data in, and then executing a program configuration instruction, after which the data is transferred to internal E²CMOS cells. It is these non-volatile cells that store the configuration or the ispPAC-POWR1220AT8. A set of instructions are defined that access all data registers and perform other internal control operations. For compatibility between compliant devices, two data registers are mandated by the IEEE 1149.1 specification. Others are functionally specified, but inclusion is strictly optional. Finally, there are provisions for optional data registers defined by the manufacturer. The two required registers are the bypass and boundary-scan registers. Figure 36 shows how the instruction and various data registers are organized in an ispPAC-POWR1220AT8.



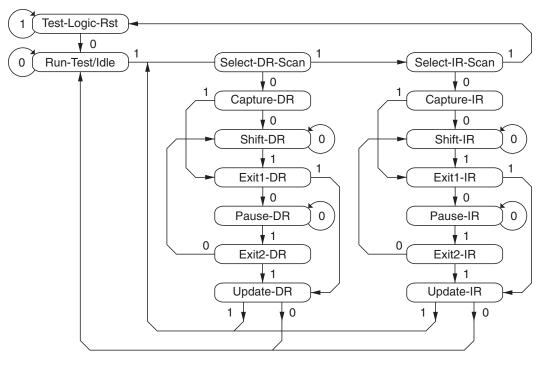


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TAP Controller Specifics

The TAP is controlled by the Test Clock (TCK) and Test Mode Select (TMS) inputs. These inputs determine whether an Instruction Register or Data Register operation is performed. Driven by the TCK input, the TAP consists of a small 16-state controller design. In a given state, the controller responds according to the level on the TMS input as shown in Figure 37. Test Data In (TDI) and TMS are latched on the rising edge of TCK, with Test Data Out (TDO) becoming valid on the falling edge of TCK. There are six steady states within the controller: Test-Logic-Reset, Run-Test/Idle, Shift-Data-Register, Pause-Data-Register, Shift-Instruction-Register and Pause-Instruction-Register. But there is only one steady state for the condition when TMS is set high: the Test-Logic-Reset state. This allows a reset of the test logic within five TCKs or less by keeping the TMS input high. Test-Logic-Reset is the power-on default state.

Figure 37. TAP States



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Note: The value shown adjacent to each state transition in this figure represents the signal present at TMS at the time of a rising edge at TCK.

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When the correct logic sequence is applied to the TMS and TCK inputs, the TAP will exit the Test-Logic-Reset state and move to the desired state. The next state after Test-Logic-Reset is Run-Test/Idle. Until a data or instruction shift is performed, no action will occur in Run-Test/Idle (steady state = idle). After Run-Test/Idle, either a data or instruction shift is performed. The states of the Data and Instruction Register blocks are identical to each other differing only in their entry points. When either block is entered, the first action is a capture operation. For the Data Registers, the Capture-DR state is very simple: it captures (parallel loads) data onto the selected serial data path (previously chosen with the appropriate instruction). For the Instruction Register, the Capture-IR state will always load the IDCODE instruction. It will always enable the ID Register for readout if no other instruction is loaded prior to a Shift-DR operation. This, in conjunction with mandated bit codes, allows a "blind" interrogation of any device in a compliant IEEE 1149.1 serial chain. From the Capture state, the TAP transitions to either the Shift or Exit1 state. Normally the Shift state follows the Capture state so that test data or status information can be shifted out or new data shifted in. Following the Shift state, the TAP either returns to the Run-Test/Idle state via the Exit1 and Update states or enters the Pause state via Exit1. The Pause state is used to temporarily suspend the shifting of data through either the Data or Instruction Register while an external operation is performed. From the Pause state, shifting can resume by reentering the Shift state via the Exit2 state or be terminated by entering the Run-Test/Idle state via the Exit2 and Update states. If the proper instruction is shifted in during a Shift-IR operation, the next entry into Run-Test/Idle initiates the test mode (steady state = test). This is when the device is actually programmed, erased or verified. All other instructions are executed in the Update state.

Test Instructions

Like data registers, the IEEE 1149.1 standard also mandates the inclusion of certain instructions. It outlines the function of three required and six optional instructions. Any additional instructions are left exclusively for the manufacturer to determine. The instruction word length is not mandated other than to be a minimum of two bits, with only the BYPASS and EXTEST instruction code patterns being specifically called out (all ones and all zeroes respectively). The ispPAC-POWR1220AT8 contains the required minimum instruction set as well as one from the optional instruction set. In addition, there are several proprietary instructions that allow the device to be configured and ver-

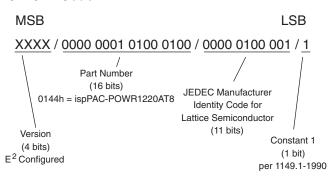
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ified. Table 13 lists the instructions supported by the ispPAC-POWR1220AT8 JTAG Test Access Port (TAP) controller:

Table 13. ispPAC-POWR1220AT8 TAP Instruction Table

| Command Code | Comments |
|-----------------|--|
| 0000 0011 | Bulk erase device |
| 1111 1111 | Bypass - connect TDO to TDI |
| 0001 0100 | Fast VPP discharge |
| 0010 0100 | Erases 'Done' bit only |
| 0000 0000 | Bypass - connect TDO to TDI |
| 0001 0110 | Read contents of manufacturer ID code (32 bits) |
| 0001 1000 | Force all outputs to High-Z state, FET outputs pulled low |
| 0001 1110 | Disable program mode |
| 0010 1111 | Programs the Done bit |
| 0001 0101 | Enable program mode |
| 0000 1001 | Program security fuse |
| 0010 0010 | Resets device (refer to the RESETb Signal, RESET Command via JTAG or I ² C section of this data sheet) |
| 0001 0010 | Reset the JTAG bit associated with IN1 pin to 0 |
| 0001 0011 | Set the JTAG bit associated with IN1 pin to 1 |
| 0010 1011 | Select non-PLD address register |
| 0010 1101 | Non-PLD data shift |
| 0010 1001Da | ERASE Just the Non PLD configuration |
| 0010 1110 | Non-PLD program |
| 0010 1000 | VRIFY non-PLD fusemap data |
| 0000 0001 | PLD_Address register (169 bits) |
| 0000 0010 | PLD_Data register (243 Bits) |
| 0010 0001 | Initialize the address register for auto increment |
| 0010 0111 | Program column register to E ² and auto increment address register |
| 0000 0111 | Program PLD data register to E ² |
| 0000 1010 | Verifies PLD column data |
| 0010 1010 | Load column register from E ² and auto increment address register |
| 0001 1010 | Program UES bits into E ² |
| 0001 0111 | Read contents of UES register from E ² (32 bits) |
| | Code 0000 0011 1111 1111 0001 0100 0010 0100 0001 0100 0001 0100 0001 0100 0001 0110 0001 1110 0001 0101 0001 0101 0001 0010 0001 0010 0001 0010 0001 0010 0001 0010 0010 1001 0010 1001 0010 1001 0010 1001 0010 1001 0010 1001 0010 1001 0010 0001 0010 0001 0010 0011 0010 0011 0010 0111 0010 0111 0010 0111 0010 0111 0010 0111 0010 0111 0010 0111 0010 1010 0010 1010 0010 1010 |

Figure 38. ispPAC-POWR1220AT8 ID Code



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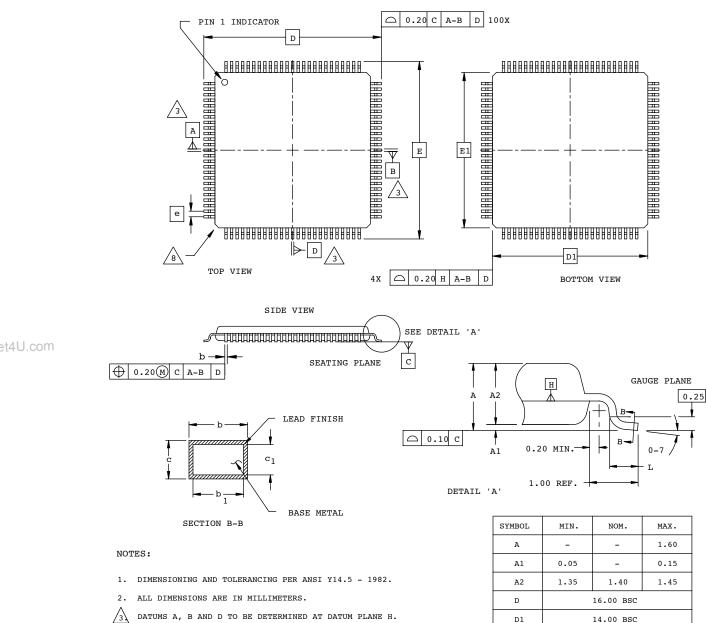
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Package Diagrams

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- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1 DIMENSIONS.
- 5. The top of package may be smaller than the bottom of the package by 0.15 mm.
- SECTION B-B: THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

/8 EXACT SHAPE OF EACH CORNER IS OPTIONAL.

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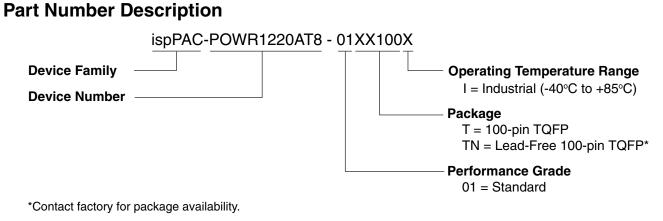
| SYMBOL | MIN. | NOM. | MAX. | | | |
|--------|-----------|----------|------|--|--|--|
| А | - | - | 1.60 | | | |
| A1 | 0.05 | - | 0.15 | | | |
| A2 | 1.35 | 1.40 | 1.45 | | | |
| D | 16.00 BSC | | | | | |
| D1 | 14.00 BSC | | | | | |
| Е | 16.00 BSC | | | | | |
| El | 14.00 BSC | | | | | |
| L | 0.45 | 0.60 | 0.75 | | | |
| N | | 100 | | | | |
| e | | 0.50 BSC | | | | |
| b | 0.17 | 0.22 | 0.27 | | | |
| b1 | 0.17 | 0.20 | 0.23 | | | |
| с | 0.09 | 0.15 | 0.20 | | | |
| c1 | 0.09 | 0.13 | 0.16 | | | |
| | | | | | | |

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ispPAC-POWR1220AT8 Ordering Information

Conventional Packaging

| Part Number | Package | Pins |
|----------------------------|---------|------|
| ispPAC-POWR1220AT8-01T100I | TQFP | 100 |

Lead-Free Packaging

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| Part Number | Package | Pins |
|-----------------------------|----------------|------|
| ispPAC-POWR1220AT8-01TN100I | Lead-Free TQFP | 100 |

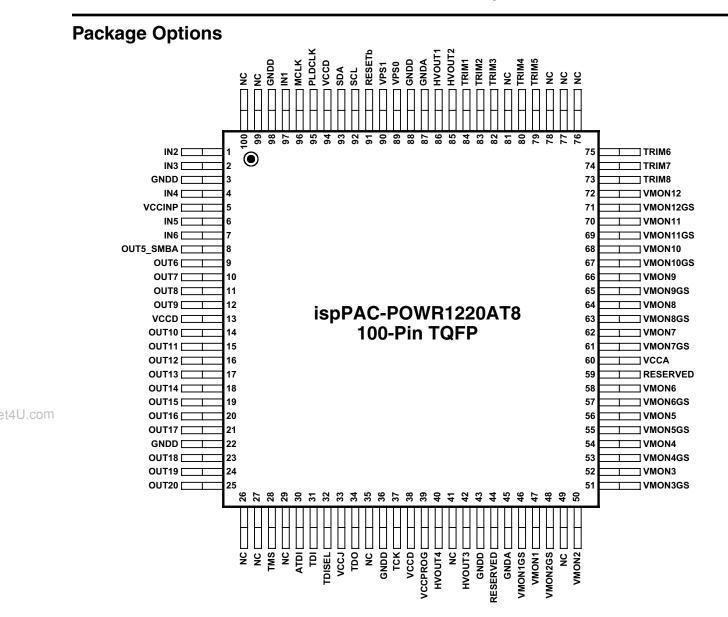
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